

170 MHz True-Color Graphics 30-Bit (Triple 10-Bit) Video RAM-DAC

ADV7150

FEATURES

170 MHz, 24-Bit (30-Bit Gamma Corrected) True Color Triple 10-Bit "Gamma Correcting" D/A Converters Triple 256 × 10 (256 × 30) Color Palette RAM On-Chip Clock Control Circuit Palette Priority Select Registers RS-343A/RS-170 Compatible Analog Outputs TTL Compatible Digital Inputs Standard MPU I/O Interface 10-Bit Parallel Structure 8+2 Byte Structure Programmable Pixel Port: 24-Bit, 15-Bit and

8-Bit (Pseudo)

Pixel Data Serializer

Multiplexed Pixel Input Ports; 1:1, 2:1, 4:1 +5 V CMOS Monolithic Construction 160-Lead Plastic Quad Flatpack (QFP)

MODES OF OPERATION

24-Bit True Color (30-Bit Gamma Corrected)

- @ 170 MHz
- @ 135 MHz
- @ 110 MHz
- @ 85 MHz

8-Bit Pseudo Color 15-Bit True Color

APPLICATIONS

High Resolution, True Color Graphics Professional Color Prepress Imaging

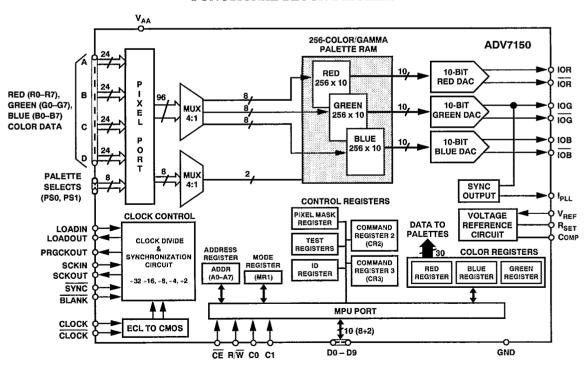
GENERAL DESCRIPTION

The ADV7150 (ADV*) is a complete analog output, Video RAM-DAC on a single CMOS monolithic chip. The part is specifically designed for use in the graphics systems of high performance, color graphics workstations. The ADV7150 integrates a number of graphic functions onto one device allowing 24-bit direct True-Color operation at the maximum screen update rate of 170 MHz. The ADV7150 implements 30-bit True Color in 24-bit frame buffer designs. The part also supports other modes, including 15-bit True Color and 8-bit Pseudo or Indexed Color. Either the Red, Green or Blue input pixel ports can be used for Pseudo Color.

*ADV is a registered trademark of Analog Devices, Inc.

(Continued on page 12)

FUNCTIONAL BLOCK DIAGRAM



REV.0

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ADV7150—SPECIFICATIONS ($V_{AA}^{1}=+5$ V; $V_{REF}=+1.235$ V; $R_{SET}=280$ Ω . 10R, 10G, 10B ($R_{L}=37.5$ Ω , $C_{L}=10$ pF); $\overline{10R}$, $\overline{10G}$, $\overline{10G}$ = GND. All Specifications T_{MIN} to T_{MAX}^{2} unless otherwise noted.)

| Parameter | All Versions | Units | Test Conditions/Comments |
|--|----------------|---|--|
| STATIC PERFORMANCE Resolution (Each DAC) Accuracy (Each DAC) | 10 | Bits | |
| Integral Nonlinearity | ±1 | LSB max | |
| Differential Nonlinearity | ±1 | LSB max | Guaranteed Monotonic |
| Gray Scale Error | ±5 | % Gray Scale max | Guaranteed Monotonic |
| Coding | | Binary | |
| DIGITAL INPUTS (Excluding CLOCK, CLOCK) | | ļ | |
| Input High Voltage, V _{INH} | 2 | V min | |
| Input Low Voltage, V _{INI} | 0.8 | V max | |
| Input Current, I _{IN} | ±10 | μA max | $V_{IN} = 0.4 \text{ V or } 2.4 \text{ V}$ |
| Input Capacitance, C _{IN} | 10 | pF max | IN SVI SZ ZIV P |
| CLOCK INPUTS (CLOCK, CLOCK) | | | |
| Input High Voltage, V _{INH} | $V_{AA}-1.0$ | V min | |
| Input Low Voltage, V _{INL} | $V_{AA} - 1.6$ | V max | |
| Input Current, I _{IN} | ±10 | μA max | $V_{IN} = 0.4 \text{ V or } 2.4 \text{ V}$ |
| Input Capacitance, C _{IN} | 10 | pF max | IN SVI V SZ ZVI V |
| DIGITAL OUTPUTS | | | |
| Output High Voltage, VOH | 2.4 | V min | $I_{SOURCE} = 400 \mu A$ |
| Output Low Voltage, VOL | 0.4 | V max | I _{SINK} = 3.2 mA |
| Floating-State Leakage Current | 20 | μA max | -51NK 5.2 1111 |
| Floating-State Output Capacitance | 20 | pF typ | |
| ANALOG OUTPUTS | | | |
| Gray Scale Current Range | 15 | mA min | |
| , c | 22 | mA max | |
| Output Current | | | |
| White Level Relative to Blank | 17.69 | mA min | Typically 19.05 mA |
| | 20.40 | mA max | |
| White Level Relative to Black | 16.74 | mA min | Typically 17.62 mA |
| 71.17 17.11 71.1 | 18.50 | mA max | |
| Black Level Relative to Blank | 0.95 | mA min | Typically 1.44 mA |
| DI LI LION TON | 1.90 | mA max | |
| Blank Level on IOR, IOB | 0 | μA min | Typically 5 μA |
| Blank Level on IOG | 50 | μA max | T 11 7.62 A |
| Diank Level on IOG | 6.29 | mA min | Typically 7.62 mA |
| Sync Level on IOG | 8.96 0 | mA max | There's a the Found |
| Sync Level on 100 | 50 | μA min | Typically 5 μA |
| LSB size | 17.22 | μA max μA typ | |
| DAC-to-DAC Matching | 2 | % max | Typically 1% |
| Output Compliance, V _{OC} | 0 | V min | Typically 170 |
| output complained, 100 | +1.4 | V max | |
| Output Impedance, R _{OUT} | 100 | kΩ typ | |
| Output Capacitance, C _{OUT} | 30 | pF max | $I_{OUT} = 0 \text{ mA}$ |
| VOLTAGE REFERENCE | | | |
| Voltage Reference Range, V _{REF} | 1.14/1.26 | V min/V max | $V_{REF} = 1.235 \text{ V for Specified Performance}$ |
| Input Current, I _{VREF} | +5 | μA typ | REF XIBS VIOLOPCONICA I CHOIMANCE |
| POWER REQUIREMENTS | | , | |
| V _{AA} | 5 | V nom | |
| I _{AA} ³ | 500 | | 170 MHz Dorto |
| *AA | i | mA max | 170 MHz Parts |
| Power Supply Rejection Ratio | 430 0.5 | mA max %/% max | 135, 110 and 85 MHz Parts Typically 0.12%/%: COMP = 0.1 μF |
| DYNAMIC PERFORMANCE | | | , , , , , , , , , , , , , , , , , , , |
| Clock and Data Feedthrough ^{4, 5} | -30 | dB typ | |
| Glitch Impulse | 50 | pV secs typ | |
| DAC-to-DAC Crosstalk ⁶ | -23 | dB typ | |
| | | | |

NOTES

 $^{^2} Temperature range (T_{MIN} to T_{MAX})$: 0°C to + 70°C; T_J (Silicon Junction Temperature) \leq 100°C.

³Pixel Port is continuously clocked with data corresponding to a linear ramp. T_J = 100°C.

⁴Clock and data feedthrough is a function of the amount of overshoot and undershoot on the digital inputs. Glitch impulse includes clock and data feedthrough. ⁵TTL input values are 0 to 3 volts, with input rise/fall times ≤3 ns, measured the 10% and 90% points. Timing reference points at 50% for inputs and outputs.

⁶ DAC-to-DAC Crosstalk is measured by holding one DAC high while the other two are making low-to-high and high-to-low transitions.

Specifications subject to change without notice.

TIMING CHARACTERISTICS 1 ($V_{AA}{}^2=+5$ V; $V_{REF}=+1.235$ V; $R_{SET}=280$ Ω . IOR, IOG, IOB ($R_L=37.5$ Ω , $C_L=10$ pF); $\overline{10R}$, $\overline{10R}$, $\overline{10R}$ = GND. All Specifications T_{MIN} to $T_{MAX}{}^3$ unless otherwise noted.)

CLOCK CONTROL AND PIXEL PORT4

| Parameter | 170 MHz Version | 135 MHz Version | 110 MHz Version | 85 MHz Version | Units | Comments |
|--------------------------------|--------------------|--------------------|--------------------|-------------------|---------|-------------------------------|
| f _{CLOCK} | 170 | 135 | 110 | 85 | MHz max | Pixel CLOCK Rate |
| t ₁ | 5.88 | 7.4 | 9.1 | 11.77 | ns min | Pixel CLOCK Cycle Time |
| t ₂ | 2.5 | 3.2 | 4 | 4 | ns min | Pixel CLOCK High Time |
| t ₃ | 2.5 | 3 | 4 | 4 | ns min | Pixel CLOCK Low Time |
| t ₄ | 16 | 16 | 16 | 16 | ns max | Pixel CLOCK to LOADOUT Delay |
| f _{LOADIN} | | | | | | LOADIN Clocking Rate |
| 1:1 Multiplexing | 85 | 67.5 | 67.5 | 67.5 | MHz max | |
| 2:1 Multiplexing | 85 | 67.5 | 55 | 42.5 | MHz max | |
| 4:1 Multiplexing | 42.5 | 33.75 | 27.5 | 21.25 | MHz max | |
| t ₅ | ! • | | | | | LOADIN Cycle Time |
| 1:1 Multiplexing | 11.76 | 14.8 | 14.8 | 14.8 | ns min | |
| 2:1 Multiplexing | 11.76 | 14.8 | 18.18 | 23.53 | ns min | |
| 4:1 Multiplexing | 23.53 | 29.63 | 36.36 | 47.1 | ns min | |
| t ₆ | | | | | | LOADIN High Time |
| 1:1 Multiplexing | 5 | 6 | 6 | 6 | ns min | |
| 2:1 Multiplexing | 6 | 6 | 8 | 9 | ns min | |
| 4:1 Multiplexing | 9 | 12 | 15 | 18 | ns min | |
| t ₇ | | İ | | | | LOADIN Low Time |
| 1:1 Multiplexing | 5 | 6 | 6 | 6 | ns min | |
| 2:1 Multiplexing | 6 | 6 | 8 | 9 | ns min | |
| 4:1 Multiplexing | 9 | 12 | 15 | 18 | ns min | |
| t ₈ | 0.5 | 0.5 | 0.5 | 0.5 | ns min | Pixel Data Setup Time |
| t ₉ | 5 | 5 | 5 | 5 | ns min | Pixel Data Hold Time |
| t ₁₀ | 0 | 0 | 0 | 0 | ns min | LOADOUT to LOADIN Delay |
| τ-t ₁₁ ⁵ | τ-7 | τ-7 | τ-7 | τ-7 | ns max | LOADOUT to LOADIN Delay |
| t_{PD}^{6} | | | | | | Pipeline Delay |
| 1:1 Multiplexing | 8 | 8 | 8 | 8 | CLOCKs | $(1 \times CLOCK = t_1)$ |
| 2:1 Multiplexing | 9 | 9 | 9 | 9 | CLOCKs | • |
| 4:1 Multiplexing | 12 | 12 | 12 | 12 | CLOCKs | |
| t ₁₂ | 16 | 16 | 16 | 16 | ns max | Pixel CLOCK to PRGCKOUT Delay |
| t ₁₃ | 5 | 5 | 5 | 5 | ns max | SCKIN to SCKOUT Delay |
| t ₁₄ | 5 | 5 | 5 | 5 | ns min | BLANK to SCKIN Setup Time |
| t ₁₅ | 1 | 1 | 1 | 1 | ns min | BLANK to SCKIN Hold Time |

ANALOG OUTPUTS7

| Parameter | 170 MHz Version | 135 MHz Version | 110 MHz Version | 85 MHz Version | Units | Comments |
|-----------------|--------------------|--------------------|--------------------|-------------------|--------|-----------------------------------|
| t ₁₆ | 25 | 25 | 25 | 25 | ns typ | Analog Output Delay |
| t ₁₇ | 1 | 1 | 1 | 1 | ns typ | Analog Output Rise/Fall Time |
| t ₁₈ | 15 | 15 | 15 | 15 | ns typ | Analog Output Transition Time |
| t _{sk} | 2 | 2 | 2 | 2 | ns max | Analog Output Skew (IOR, IOG, IOB |
| J.C. | 0 | 0 | 0 | 0 | ns typ | |

MPU PORT8, 9

| Parameter | 170 MHz Version | 135 MHz Version | 110 MHz Version | 85 MHz Version | Units | Comments |
|--|--------------------|--------------------|--------------------|-------------------|----------------------------|--|
| t ₁₉ t ₂₀ t | 0 10 50 | 0 10 50 | 0 10 50 | 0 10 50 | ns min ns min ns min | R/W, C0, C1 to CE Setup Time R/W, C0, C1 to CE Hold Time CE Low Time |
| t ₂₁ t ₂₂ t ₂₃ ⁸ | 25 | 25 | 25 | 25 | ns min | CE High Time CE Asserted to Databus Driven |
| t ₂₄ 9 | 50 | 50 | 50 | 50 | ns max | CE Asserted to Data Valid |
| t ₂₅ ⁹ | 20 5 20 | 20 5 20 | 20 5 20 | 20 5 20 | ns max ns min ns min | CE Disabled to Databus Three-Stated Write Data (D0-D9) Setup Time |
| t ₂₆ t ₂₇ | 5 | 5 | 5 | 5 | ns min | Write Data (D0–D9) Hold Time |

NOTES

¹TTL input values are 0 to 3 volts, with input rise/fall times ≤ 3 ns, measured between the 10% and 90% points. ECL inputs (CLOCK, $\overline{\text{CLOCK}}$) are V_{AA} – 0.8 V to V_{AA} – 1.8 V, with input rise/fall times ≤ 2 ns, measured between the 10% and 90% points. Timing reference points at 50% for inputs and outputs. Analog output load ≤ 10 pF. Databus (D0–D9) loaded as shown in Figure 1. Digital output load for LOADOUT, PRGCKOUT and SCKOUT ≤ 30 pF. 2 ±5% for all versions.

³Temperature Range (T_{MIN} to T_{MAX}); 0°C to + 70°C; T_J (Silicon Junction Temperature) ≤ 100°C.

Pixel Port consists of the following inputs: Pixel Inputs: RED [A, B, C, D]; GREEN [A, B, C, D]; BLUE [A, B, C, D]. Palette Selects: PS0 [A, B, C, D]; PS1 [A, B, C, D]; Pixel Controls: SYNC, BLANK; Clock Inputs: CLOCK, CLOCK, LOADIN, SCKIN; Clock Outputs: LOADOUT, PRGCKOUT, SCKOUT.

 $^{5}\tau$ is the LOADOUT Cycle Time and is a function of the Pixel CLOCK Rate and the Multiplexing Mode: 1:1 Multiplexing; $\tau = \text{CLOCK} = t_1$ ns. 2:1 Multiplexing; $\tau = \text{CLOCK} \times 2 = 2 \times t_1$ ns. 4:1 Multiplexing; $\tau = \text{CLOCK} \times 4 = 4 \times t_1$ ns.

These fixed values for Pipeline Delay are valid under conditions where t_{10} and τ - t_{11} are met. If either t_{10} or τ - t_{11} are not met, the part will operate but the Pipeline Delay is increased by between 1 and 4 additional CLOCK cycles.

Output delay measured from the 50% point of the rising edge of CLOCK to the 50% point of full-scale transition. Output rise/fall time measured between the 10% and 90% points of full-scale transition. Transition time measured from the 50% point of full-scale transition to the output remaining within 2% of the final output value (Transition time does not include clock and data feedthrough).

⁸t₂₃ and t₂₄ are measured with the load circuit of Figure 1 and defined as the time required for an output to cross 0.4 V or 2.4 V.

⁹t₂₅ is derived from the measured time taken by the data outputs to change by 0.5 V when loaded with the circuit of Figure 1. The measured number is then extrapolated back to remove the effects of charging the 100 pF capacitor. This means that the time, t₂₅, quoted in the Timing Characteristics is the true value for the device and as such is independent of external databus loading capacitances.

Specifications subject to change without notice.

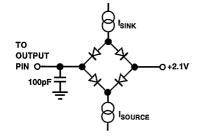


Figure 1. Load Circuit for Databus Access and Relinquish Times

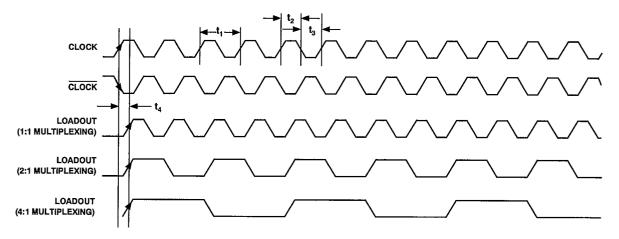
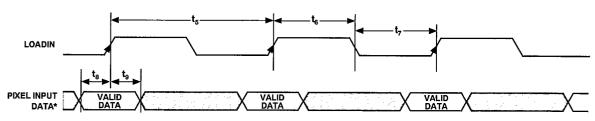


Figure 2. LOADOUT vs. Pixel Clock Input (CLOCK, CLOCK)



*INCLUDES PIXEL DATA (RO-R7, GO-G7, BO-B7); PALETTE SELECT INPUTS (PSO-PS1); BLANK; SYNC

Figure 3. LOADIN vs. Pixel Input Data

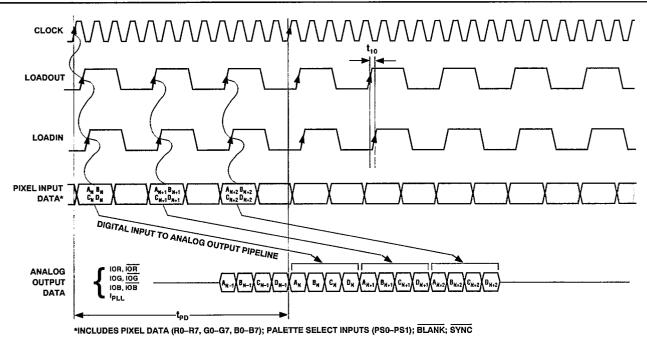


Figure 4. Pixel Input to Analog Output Pipeline with Minimum LOADOUT to LOADIN Delay (4:1 Multiplex Mode)

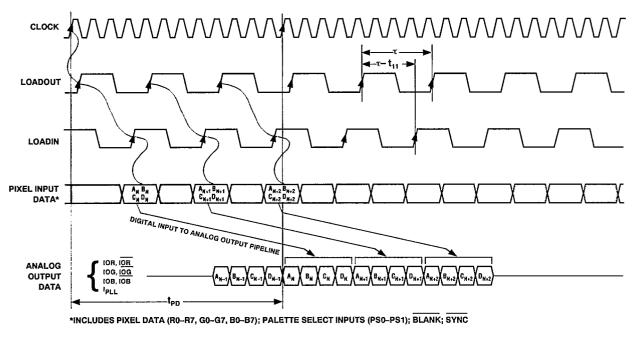


Figure 5. Pixel Input to Analog Output Pipeline with Maximum LOADOUT to LOADIN Delay (4:1 Multiplex Mode)

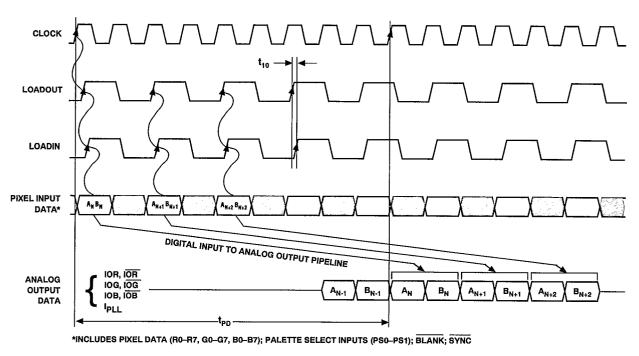


Figure 6. Pixel Input to Analog Output Pipeline with Minimum LOADOUT to LOADIN Delay (2:1 Multiplex Mode)

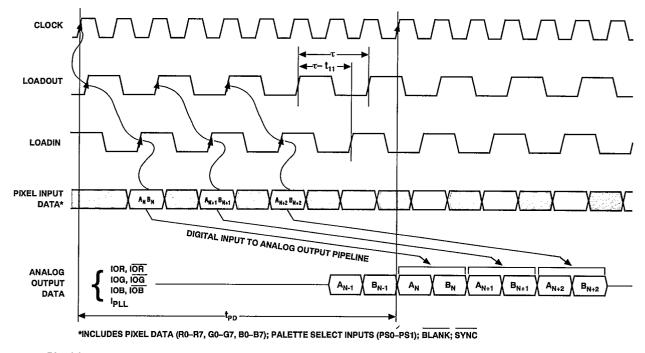


Figure 7. Pixel Input to Analog Output Pipeline with Maximum LOADOUT to LOADIN Delay (2:1 Multiplex Mode)

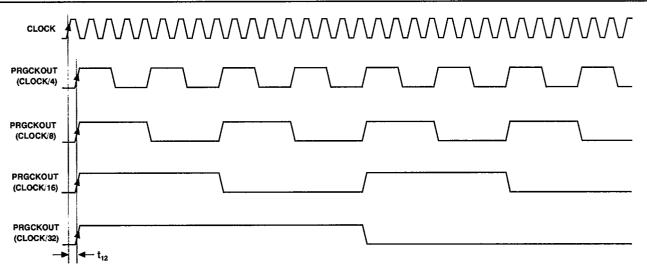


Figure 8. Pixel Clock Input vs. Programmable Clock Output (PRGCKOUT)

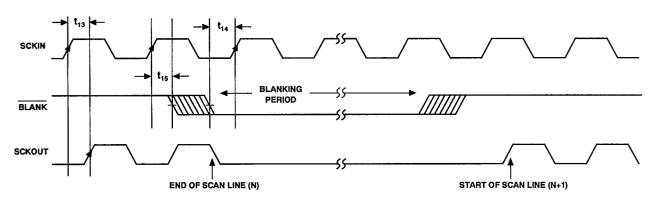


Figure 9. Video Data Shift Clock Input (SCKIN) and BLANK vs. Video Data Shift Clock Output (SCKOUT)

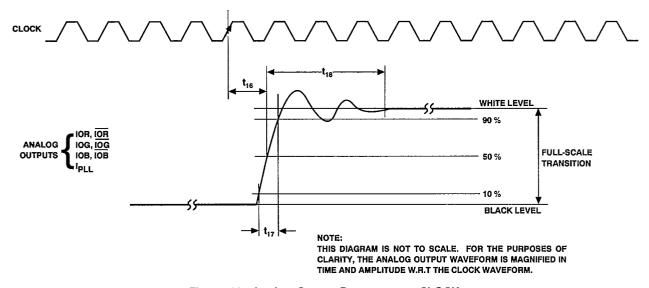


Figure 10. Analog Output Response vs. CLOCK

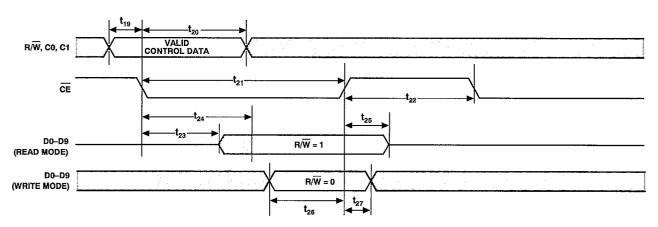


Figure 11. Microprocessor Port (MPU) Interface Timing

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Min | Тур | Max | Units |
|-------------------------------|-----------------|------|-------|------|----------|
| Power Supply | V _{AA} | 4.75 | 5.00 | 5.25 | Volts |
| Ambient Operating Temperature | T_A | 0 | | +70 | °C |
| Reference Voltage | V_{REF} | 1.14 | 1.235 | 1.26 | Volts |
| Output Load | R_{L} | | 37.5 | | Ω |

CAUTION

ESD (electrostatic discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subject to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The protective foam should be discharged to the destination socket before devices are inserted.



ABSOLUTE MAXIMUM RATINGS*

| V _{AA} to GND |
|---|
| Voltage on Any Digital Pin GND -0.5 V to $V_{AA} + 0.5 \text{ V}$ |
| Ambient Operating Temperature $(T_A) \dots -55^{\circ}C$ to $+125^{\circ}C$ |
| Storage Temperature $(T_S) \dots -65^{\circ}C$ to $+150^{\circ}C$ |
| Junction Temperature $(T_J) \dots + 150^{\circ}C$ |
| Lead Temperature (Soldering, 10 secs) +300°C |
| Vapor Phase Soldering (1 minute) +220°C |
| Analog Outputs to $GND^1 \dots GND - 0.5$ to V_{AA} |
| NOTES |

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Analog Output Short Circuit to any Power Supply or Common can be of an indefinite duration.

ORDERING GUIDE^{1, 2, 3}

| Speed | | | | | |
|--------------------------------|--------------|--------------|-------------|--|--|
| 170 MHz 135 MHz 110 MHz 85 MHz | | | | | |
| ADV7150KS170 | ADV7150KS135 | ADV7150KS110 | ADV7150KS85 | | |

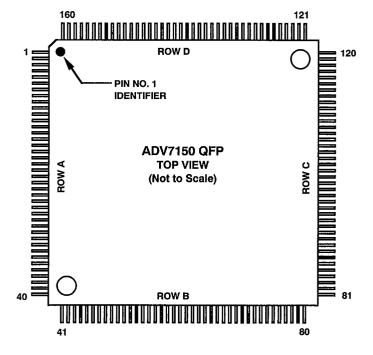
NOTES

¹ADV7150 is packaged in a 160-pin plastic quad flatpack, QFP.

²All devices are specified for 0°C to +70°C operation.

³Contact Sales Office for latest information on package design.

160-LEAD QFP CONFIGURATION



ADV7150 PIN ASSIGNMENTS

| Pin | | Pin | | Pin | | Pin | 1,5 |
|--------|------------------|--------|----------------------------|--------|------------------|--------|-------------------|
| Number | Mnemonic | Number | Mnemonic | Number | Mnemonic | Number | Mnemonic |
| 1 | G3 _A | 41 | PS1 _D | 81 | NC | 121 | R1 _A |
| 2 | G3 _B | 42 | $B0_A$ | 82 | D2 | 122 | R1 _B |
| 3 | G3 _C | 43 | $\mathrm{B0}_{\mathrm{B}}$ | 83 | NC | 123 | R1 _C |
| 4 | G3 _D | 44 | $B0_{C}$ | 84 | GND | 124 | R1 _D |
| 5 | G4 _A | 45 | ${ m B0}_{ m D}$ | 85 | GND | 125 | R2 _A |
| 6 | G4 _B | 46 | B1 _A | 86 | GND | 126 | R2 _B |
| 7 | G4 _C | 47 | Bl _B | 87 | D3 | 127 | R2 _C |
| 8 | G4 _D | 48 | B1 _C | 88 | D4 | 128 | R2 _D |
| 9 | G5 _A | 49 | $\mathrm{B1}_{\mathrm{D}}$ | 89 | D5 | 129 | R3 _A |
| 10 | G5 _B | 50 | B2 _A | 90 | V _{AA} | 130 | R3 _B |
| 11 | G5 _C | 51 | $B2_{B}$ | 91 | D6 | 131 | R3 _C |
| 12 | G5 _D | 52 | B2 _C | 92 | D7 | 132 | R3 _D |
| 13 | CLOCK | 53 | $B2_{D}$ | 93 | D8 | 133 | R4 _A |
| 14 | CLOCK | 54 | B3 _A | 94 | D9 | 134 | R4 _B |
| 15 | LOADIN | 55 | B3 _B | 95 | GND | 135 | R4 _C |
| 16 | LOADOUT | 56 | B3 _C | 96 | GND | 136 | R4 _D |
| 17 | V _{AA} | 57 | B3 _D | 97 | GND | 137 | R5 _A |
| 18 | V _{AA} | 58 | B4 _A | 98 | ĪOB | 138 | R5 _B |
| 19 | PRGCKOUT | 59 | B4 _B | 99 | ĪOR | 139 | R5 _C |
| 20 | SCKIN | 60 | B4 _C | 100 | ĪOG | 140 | R5 _D |
| 21 | SCKOUT | 61 | B4 _D | 101 | IOB | 141 | R6 _A |
| 22 | GND | 62 | B5 _A | 102 | IOG | 142 | R6 _B |
| 23 | GND | 63 | B5 _B | 103 | V _{AA} | 143 | R6 _C |
| 24 | GND | 64 | B5 _C | 104 | V _{AA} | 144 | R6 _D |
| 25 | GND | 65 | B5 _D | 105 | V _{AA} | 145 | R7 _A |
| 26 | G6 _A | 66 | $B6_A$ | 106 | IOR | 146 | R7 _B |
| 27 | G6 _B | 67 | B6 _B | 107 | COMP | 147 | R7 _C |
| 28 | G6 _C | 68 | B6 _C | 108 | V _{REF} | 148 | R7 _D |
| 29 | G6 _D | 69 | $B6_{D}$ | 109 | R _{SET} | 149 | G0 _A |
| 30 | G7 _A | 70 | B7 _A | 110 | I_{PLL} | 150 | $G0_{B}$ |
| 31 | G7 _B | 71 | B7 _B | 111 | GND | 151 | G0 _℃ |
| 32 | G7 _C | 72 | B7 _C | 112 | V _{AA} | 152 | $G0_{\mathbf{D}}$ |
| 33 | G7 _D | 73 | B7 _D | 113 | V _{AA} | 153 | G1 _A |
| 34 | PSO _A | 74 | CE | 114 | V _{AA} | 154 | $G1_{B}$ |
| 35 | PSO _B | 75 | R/W | 115 | SYNC | 155 | G1 _C |
| 36 | PSO _C | 76 | C0 | 116 | BLANK | 156 | $Gl_{\mathbf{D}}$ |
| 37 | PSO _D | 77 | C1 | 117 | R0 _A | 157 | G2 _A |
| 38 | PS1 _A | 78 | D0 | 118 | RO _B | 158 | G2 _B |
| 39 | PS1 _B | 79 | D1 | 119 | RO _C | 159 | G2 _C |
| 40 | PS1 _C | 80 | GND | 120 | R0 _D | 160 | G2 _D |

NC = No Connect.

PIN FUNCTION DESCRIPTION

| Mnemonic | Function |
|---|---|
| RED (R0 _A R0 _D -R7 _A I | R7 _D), GREEN (G0 _A G0 _D -G7 _A G7 _D), BLUE (B0 _A B0 _D -B7 _A B7 _D) Pixel Port (TTL Compatible Inputs): 96 pixel select inputs, with 8 bits each for Red, 8 bits for Green and 8 bits for Blue. Each bit is multiplexed [A-D] 4:1, 2:1 or 1:1. It can be configured for 24-Bit True-Color Data, 8-Bit Pseudo-Color Data and 15-Bit True-Color Data formats. Pixel Data is latched into the device on the rising edge of LOADIN. |
| $PSO_A \dots PSO_D$, $PSI_A \dots PSI$ | |
| | Palette Priority Selects (TTL Compatible Inputs). These pixel port select inputs determine whether or not the device's pixel data port is selected on a pixel-by-pixel basis. The palette selects allow switching between multiple palette devices. The device can be preprogrammed to completely shut off the DAC analog outputs. If the values of PS0 and PS1 match the values programmed into bits MR16 and MR17 of the Mode Register, then the device is selected. Each bit is multiplexed [A-D] 4:1, 2:1 or 1:1. PS0 and PS1 are latched into the device on the rising edge of LOADIN. |
| LOADIN | Pixel Data Load Input (TTL Compatible Input). This input latches the multiplexed pixel data, including PS0-PS1, BLANK and SYNC into the device. |
| LOADOUT | Pixel Data Load Output (TTL Compatible Output). This output control signal runs at a divided down frequency of the pixel CLOCK input. Its frequency is a function of the multiplex rate. It can be used to directly or indirectly drive LOADIN $f_{LOADOUT} = f_{CLOCK}/M$ |
| | where $M = 1$ for 1:1 Multiplex Mode $M = 2$ for 2:1 Multiplex Mode $M = 4$ for 4:1 Multiplex Mode. |
| PRGCKOUT | Programmable Clock Output (TTL Compatible Output). This output control signal runs at a divided down frequency of the pixel CLOCK input. Its frequency is user programmable and is determined by bits CR30 and CR31 of Command Register 3 |
| | $f_{PRGCKOUT} = f_{CLOCK}/N$ where $N = 4$, 8, 16 and 32. |
| SCKIN | Video Shift Clock Input (TTL Compatible Input). The signal on this input is internally gated synchronously with the BLANK signal. The resultant output, SCKOUT, is a video clocking signal that is stopped during video blanking periods. |
| SCKOUT | Video Shift Clock Output (TTL Compatible Output). This output is a synchronously gated version of SCKIN and BLANK. SCKOUT, is a video clocking signal that is stopped during video blanking periods. |
| CLOCK, CLOCK | Clock Inputs (ECL Compatible Inputs). These differential clock inputs are designed to be driven by ECL logic levels configured for single supply (+5 V) operation. The clock rate is normally the pixel clock rate of the system. |
| BLANK | Composite Blank (TTL Compatible Input). This video control signal drives the analog outputs to the blanking level. |
| SYNC | Composite-Sync Input (TTL Compatible Input). This video control signal drives the IOG analog output to the SYNC level. It is only asserted during the blanking period. CR22 in Command Register 2 must be set if SYNC is to be decoded onto the analog output, otherwise the SYNC input is ignored. |
| D0-D9 | Databus (TTL Compatible Input/Output Bus). Data, including color palette values and device control information is written to and read from the device over this 10-bit, bidirectional databus. 10-bit data or 8-bit data can be used. The databus can be configured for either 10-bit parallel data or byte data (8+2) as well as standard 8-bit data. Any unused bits of the databus should be terminated through a resistor to either the digital power plane (V_{CC}) or GND. |
| CE | Chip Enable (TTL Compatible Input). This input must be at logic "0" when writing to or reading from the device over the databus (D0-D9). Internally, data is latched on the rising edge of $\overline{\text{CE}}$. |
| R/W | Read/Write Control (TTL Compatible Input). This input determines whether data is written to or read from the device's registers and color palette RAM. R/\overline{W} and \overline{CE} must be at logic "0" to write data to the part. R/\overline{W} must be at logic "1" and \overline{CE} at logic "0" to read from the device. |

| Mnemonic | Function | | | | |
|--|---|--|--|--|--|
| CO, C1 | Command Controls (TTL Compatible Inputs). These inputs determine the type of read or write operation being performed on the device over the databus (see Interface Truth Table). Data on these inputs is latched on the falling edge of \overline{CE} . | | | | |
| IOR; \overline{IOR} , IOG; \overline{IOG} , IOB; | | | | | |
| | Red, Green and Blue Current Outputs (High Impedance Current Sources). These RGB video outputs are specified to directly drive RS-343A and RS-170 video levels into doubly terminated 75 Ω loads. | | | | |
| | $\overline{\text{IOR}}$, $\overline{\text{IOG}}$ and $\overline{\text{IOB}}$ are the complementary outputs of IOR, IOG and IOB. These outputs can be tied to GND if it is not required to use differential outputs. | | | | |
| V_{REF} | Voltage Reference Input (Analog Input). An external 1.235 V voltage reference is required to drive this input. An AD589 (2-terminal voltage reference) or equivalent is recommended. The AD730 clock generator also has a suitable $V_{\rm REF}$ Output. (Note: It is not recommended to use a resistor network to generate the voltage reference.) | | | | |
| R _{SET} | Output Full Scale Adjust Control (Analog Input). A resistor connected between this pin and analog ground controls the absolute amplitude of the output video signal. The value of $R_{\rm SET}$ is derived from the full-scale output current on IOG according to the following equations: | | | | |
| | $R_{SET}(\Omega) = C_I \times V_{REF}/IOG \ (mA);$ SYNC on GREEN $R_{SET}(\Omega) = C_2 \times V_{REF}/IOG \ (mA);$ No SYNC on GREEN. | | | | |
| | Full-Scale output currents on IOR and IOB for a particular value of R _{SET} are given by: | | | | |
| | $IOR(mA) = C_2 \times V_{REF}(V) / R_{SET}(\Omega)$ | | | | |
| | and $IOB (mA) = C_2 \times V_{REF} (V) / R_{SET} (\Omega)$ | | | | |
| | where $C_1 = 6,050$; PEDESTAL = 7.5 IRE = 5,723; PEDESTAL = 0 IRE | | | | |
| | and $C_2 = 4,323$; PEDESTAL = 7.5 IRE = 3,996; PEDESTAL = 0 IRE. | | | | |
| COMP | Compensation Pin. A 0.1 μF capacitor should be connected between this pin and V_{AA} . | | | | |
| I _{PLL} | Phase Lock Loop Output Current (High Impedance Current Source). This output is used to enable multiple ADV7150s along with ADV7151s to be synchronized together with pixel resolution when using an external PLL. This output is triggered either from the falling edge of SYNC or BLANK as determined by bit CR21 of Command Register 2. When activated, it supplies a current corresponding to: | | | | |
| | I_{PLL} (mA) = 1,728 × V_{REF} (V)/ R_{SET} (Ω). | | | | |
| | When not using the I _{PLL} function, this output pin should be tied to GND. | | | | |
| V_{AA} | Power Supply (+5 V \pm 5%). The part contains multiple power supply pins, all should be connected together to one common +5 V filtered analog power supply. | | | | |
| GND | Analog Ground. The part contains multiple ground pins, all should be connected together to the system's ground plane. | | | | |

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ADV7150

(Continued from page 1)

The device consists of three, high speed, 10-bit, video D/A converters (RGB), three 256 \times 10 (one 256 \times 30) color look-up tables, palette priority selects, a pixel input data multiplexer/ serializer and a clock generator/divider circuit. The ADV7150 is capable of 1:1, 2:1 and 4:1 multiplexing. The on-board palette priority select inputs enable multiple palette devices to be connected together for use in multipalette and window applications. The part is controlled and programmed through the microprocessor (MPU) port. The part also contains a number of on-board test registers, associated with self diagnostic testing of the device. The individual Red, Green and Blue pixel input ports allow True-Color, image rendition. True-Color image rendition, at speeds of up to 170 MHz, is achieved through the use of the on-board data multiplexer/serializer. The pixel input port's flexibility allows for direct interface to most standard frame buffer memory configurations.

The 30 bits of resolution, associated with the color look-up table and triple 10-bit DAC, realizes 24-bit True-Color resolution,

while also allowing for the on-board implementation of linearization algorithms, such as Gamma-Correction. This allows effective 30-Bit True-Color operation.

The on-chip video clock controller circuit generates all the internal clocking and some additional external clocking signals. An external ECL oscillator source with differential outputs is all that is required to drive the CLOCK and CLOCK inputs of the ADV7150. The part can also be driven by an external clock generator chip circuit, such as the AD730.

The ADV7150 is capable of generating RGB video output signals which are compatible with RS-343A and RS-170 video standards, without requiring external buffering.

Test diagnostic circuitry has been included to complement the users system level debugging.

The ADV7150 is fabricated in a +5 V CMOS process. Its monolithic CMOS construction ensures greater functionality with low power dissipation.

The ADV7150 is packaged in a plastic 160-pin quad flatpack (QFP).

CIRCUIT DETAILS AND OPERATION

OVERVIEW

Digital video or pixel data is latched into the ADV7150 over the devices Pixel Port. This data acts as a pointer to on-board Color Palette RAM. The data at the RAM address pointed to is latched to the digital-to-analog converters (DACs) and output as an RGB analog video signal.

For the purposes of clarity of description, the ADV7150 is broken down into three separate functional blocks. These are:

- 1. Pixel port and clock control circuit
- 2. MPU port, registers and color palette
- 3. Digital-to-analog converters and video outputs

Table I shows the architectural and packaging differences between the other devices in the ADV715x series of workstation parts. (For more details consult the relevant data sheets.)

Table I. Architectural and Packaging Differences of the ADV715x Series

| Description | ADV7150 | ADV7152* | ADV7151* |
|-------------------------------|---------|----------|----------|
| 24-Bit "Gamma" True Color | • | • | |
| 24-Bit "Standard" True Color | • | • | |
| 8-Bit "Gamma" Pseudo Color | • | • | • |
| 8-Bit "Standard" Pseudo Color | • | • | • |
| 15-Bit True Color | • | • | |
| 170 MHz-True Color | • | • | |
| 170 MHz-Pseudo Color | • | • | • |
| Triple 10-Bit DACs | • | • | • |
| 4:1 Multiplexing | • | | • |
| 2:1 Multiplexing | • | • | • |
| 1:1 Multiplexing | • | • | • |
| 160-Lead QFP | • | | |
| 100-Lead QFP | | • | • |

^{*}See ADV7151 and ADV7152 data sheets for more information on these parts.

Pixel Port and Clock Control Circuit

The Pixel Port of the ADV7150 is directly interfaced to the video/graphics pipeline of a computer graphics subsystem. It is connected directly or through a gate array to the video RAM of the systems Frame-Buffer (video memory). The pixel port on the device consists of:

Color Data RED, GREEN, BLUE Pixel Controls SYNC, BLANK

Palette Selects PS0-PS1

The associated clocking signals for the pixel port include:

Clock Inputs CLOCK, CLOCK, LOADIN, SCKIN

Clock Outputs LOADOUT, PRGCKOUT,

SCKOUT

These on-board clock control signals are included to simplify interfacing between the part and the frame buffer. Only two control input signals are necessary to get the part operational, CLOCK and CLOCK (ECL Levels). No additional signals or external glue logic are required to get the *Pixel Port and Clock Control Circuit* of the part operational.

Pixel Port (Color Data)

The ADV7150 has 96 color data inputs. The part has four (for 4:1 multiplexing) 24-bit wide direct color data inputs. These are user programmed to support a number of color data formats including 24-Bit True Color, 15-Bit True Color and 8-Bit Pseudo Color (see "Color Data Formats" section) in 4:1, 2:1 and 1:1 multiplex modes.

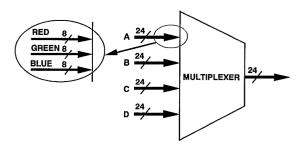


Figure 12. Multiplexed Color Inputs for the ADV7150

Color data is latched into the parts pixel port on every rising edge of LOADIN (see Timing Waveform Figure 3). The required frequency of LOADIN is determined by the multiplex rate, where:

 $\begin{array}{l} f_{\rm LOADIN} = f_{\rm CLOCK}/4 & 4:1 \; \text{Multiplex Mode} \\ f_{\rm LOADIN} = f_{\rm CLOCK}/2 & 2:1 \; \text{Multiplex Mode} \\ f_{\rm LOADIN} = f_{\rm CLOCK} & 1:1 \; \text{Multiplex Mode} \end{array}$

Other pixel data signals latched into the device by LOADIN include SYNC, BLANK and PS0-PS1.

Internally, data is pipelined through the part by the differential pixel clock inputs, CLOCK and CLOCK. The LOADIN control signal needs only have a frequency synchronous relationship to the pixel CLOCK (see "Pipeline Delay and On-Board Calibration" section). A completely phase independent LOADIN signal can be used with the ADV7150, allowing the CLOCK to occur anywhere during the LOADIN cycle.

Alternatively, the LOADOUT signal of the ADV7150 can be used. LOADOUT can be connected either directly or indirectly to LOADIN. Its frequency is automatically set to the correct LOADIN requirement.

SYNC, BLANK

The BLANK and SYNC video control signals drive the analog outputs to the blanking and SYNC levels respectively. These signals are latched into the part on the rising edge of LOADIN. The SYNC information is encoded onto the IOG analog signal when Bit CR22 of Command Register 2 is set to a Logic "1." The SYNC input is ignored if CR22 is set to "0."

PS0-PS1 (Palette Priority Select Inputs)

These pixel port select inputs determine whether or not the device is selected. These controls effectively determine whether the devices RGB analog outputs are turned-on or shut down. When the analog outputs are shut down, IOR, IOG and IOB are forced to 0 mA regardless of the state of the pixel and control data inputs. This state is determined on a pixel-by-pixel basis as the PSO-PS1 inputs are multiplexed in exactly the same format as the pixel port color data. These controls allow for switching between multiple palette devices (see Appendix 4). If the values of PS0 and PS1 match the values programmed into bits MR16 and MR17 of the Mode Register, then the device is selected, if there is no match the device is effectively shut down.

Multiplexing

The on-board multiplexers of the ADV7150 eliminate the need for external data serializer circuits. Multiple video memory devices can be connected, in parallel, directly to the device. Figure 13 shows four memory banks of 33 MHz memory connected

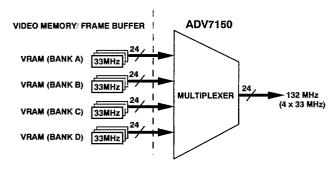


Figure 13. Direct Interfacing of Video Memory to ADV7150

to the ADV7150, running in 4:1 multiplex mode, giving a resultant pixel or dot clock rate of 132 MHz. As mentioned in the previous section, the ADV7150 supports a number of color data formats in 4:1, 2:1 and 1:1 multiplex modes.

In 1:1 multiplex mode, the ADV7150 is clocked using the LOADIN signal. This means that there is no requirement for differential ECL inputs on CLOCK and CLOCK. The pixel clock is connected directly to LOADIN. (Note: The ECL CLOCK can still be used to generate LOADOUT PRGCKOUT etc.)

CLOCK CONTROL CIRCUIT

The ADV7150 has an integrated Clock Control Circuit (Figure 14). This circuit is capable of both generating the ADV7150's internal clocking signals as well as external graphics subsystem clocking signals. Total system synchronization can be attained by using the parts output clocking signals to drive the controlling graphics processor's master clock as well as the video frame buffers shift clock signals.

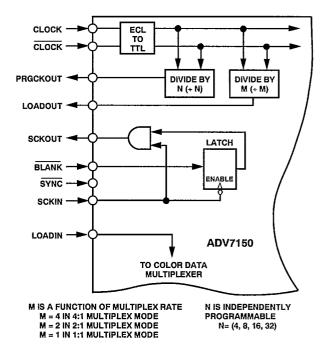
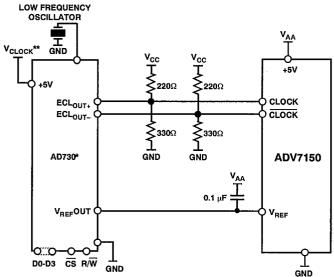


Figure 14. Clock Control Circuit of the ADV7150

CLOCK, CLOCK Inputs

The Clock Control Circuit is driven by the pixel clock inputs, CLOCK and CLOCK. These inputs can be driven by a differential ECL oscillator running from a +5 V supply.

Alternatively, the ADV7150 CLOCK inputs can be driven by a Programmable Clock Generator (Figure 15), such as the AD730 (available from Analog Devices). The AD730 is a monolithic, phase-locked-loop, clock generator chip. It is capable of synthesizing differential ECL output frequencies in a range from 66 MHz up to 220 MHz from a single low frequency reference crystal.



* SEE AD730 DATA SHEET FOR FULL DETAILS

** V_{CLOCK} REPRESENTS THE VARIOUS POWER SUPPLY PINS ON THE AD730

Figure 15. AD730 Clock Generator Driving CLOCK, CLOCK of the ADV7150

CLOCK CONTROL SIGNALS LOADOUT

The ADV7150 generates a LOADOUT control signal which runs at a divided down frequency of the pixel CLOCK. The frequency is automatically set to the programmed multiplex rate, controlled by CR37 and CR36 of Command Register 3.

 $f_{LOADOUT} = f_{CLOCK}/4$ 4:1 multiplex mode $f_{LOADOUT} = f_{CLOCK}/2$ 2:1 multiplex mode $f_{LOADOUT} = f_{CLOCK}$ 1:1 multiplex mode

The LOADOUT signal is used to directly drive the LOADIN pixel latch signal of the ADV7150. This is most simply achieved by tying the LOADOUT and LOADIN pins together. Alternatively, the LOADOUT signal can be used to drive the frame buffer's shift clock signals, returning to the LOADIN input delayed with respect to LOADOUT.

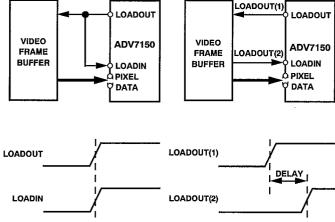


Figure 16. LOADOUT vs. Pixel Clock Input (CLOCK, CLOCK)

If it is not necessary to have a known fixed number of pipeline delays, then there is no limitation on the delay between LOAD-OUT and LOADIN (LOADOUT(1) and LOADOUT(2)).

LOADIN and Pixel Data must conform to the setup and hold times $(t_8$ and $t_9)$.

If however, it is required that the ADV7150 has a fixed number of pipeline delays ($t_{\rm PD}$), LOADOUT and LOADIN must conform to timing specifications t_{10} and τ - t_{11} as illustrated in Figures 4 to 7.

PRGCKOUT

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The PRGCKOUT control signal outputs a user programmable clock frequency. It is a divided down frequency of the pixel CLOCK (see Figure 8). The rising edge of PRGCKOUT is synchronous to the rising edge of LOADOUT.

$$f_{PRGCKOUT} = f_{CLOCK}/N$$

where N = 4, 8, 16 or 32

One application of the PRGCKOUT is to use it as the master clock frequency of the graphics subsystems processor or controller.

SCKIN, SCKOUT

These video memory signals are used to minimize external support chips. Figure 17 illustrates the function that is provided. An input signal applied to SCKIN is synchronously AND-ed with the video blanking signal (BLANK). The resulting signal is output on SCKOUT. Figure 9 of the Timing Waveform section shows the relationship between SCKOUT, SCKIN and BLANK.

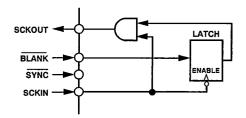


Figure 17. SCKOUT Generation Circuit

The SCKOUT signal is essentially the video memory shift control signal. It is stopped during the screen retrace. Figure 18 shows a suggested frame buffer to ADV7150 interface. This is a minimum chip solution and allows the ADV7150 control the overall graphics system clocking and synchronization.

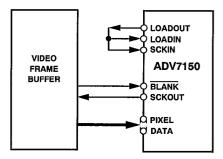


Figure 18. ADV7150 Interface Using SCKIN and SCKOUT

Pipeline Delay and On-Board Calibration

The ADV7150 has a fixed number of pipeline delays (t_{PD}), so long as timings t_{10} and τ - t_{11} are met. However, as described earlier, the part will function correctly if these times are not met, though with an indeterminate number of pipeline delays ($t_{PD}+1$ to 4 CLOCKS). This is not an issue if the ADV7150 is the sole interface to the computer's monitor, in other words, in applications where the on-board composite $\overline{\text{SYNC}}$ on IOG is used to synchronize the monitor as well as systems which do not implement multiple ADV7150 and ADV7151s simultaneously. In such applications there is no restriction on LOADIN to LOADOUT timing. The ADV7150 has on-board calibration circuitry which synchronizes pixel data and LOADIN with the internal ADV7150 clocking signals. Calibration is performed during the devices initialization sequence by toggling two bits of the Mode Register, MR10 followed by MR15.

COLOR VIDEO MODES

The ADV7150 supports a number of color video modes all at the maximum video rate.

Command bits CR24-CR27 of Command Register 2 along with Bit MR11 of Mode Register 1 determine the color mode.

24-Bit "Gamma" True Color (CR25, CR26, CR27 = 1, 1, 1 and MR11 = 1)

The part is set to 24-bit/30-bit True-Color operation. The pixel port accepts 24-bits of color data which is directly mapped to the Look-Up Table RAM. The Look-Up Table is configured as a 256 location by 30 bits deep RAM (10 bits each for Red, Green and Blue). The output of the RAM drives the DACs with 30-bit data (10 bits each for Red, Green and Blue). The RAM is preloaded with a user determined, nonlinear function, such as a gamma correction curve.

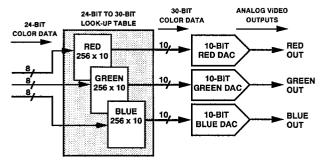


Figure 19. 24-Bit to 30-Bit True-Color Configuration

This mode allows for the display of full 24-bit, Gamma-Corrected True-Color Images.

24-Bit "Standard" True Color (CR25, CR26, CR27 = 1, 1, 1 and MR11 = 0)

This mode sets the part into direct 24-bit True-Color operation. The pixel port accepts 24-bits of color data which is directly mapped to Look-Up Table RAM. The Look-Up Table is configured as a 256 location by 24 bits deep RAM (8 bits each for Red, Green and Blue) and essentially acts as a by-pass RAM. The output of the RAM drives the DACs with 24-bit data (8 bits each for Red, Green and Blue). The RAM is preloaded with a linear function.

This mode allows for the display of full 24-bit True-Color Images.

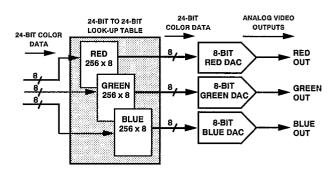


Figure 20. 24-Bit to 24-Bit Direct True-Color Configuration

8-Bit "Gamma" Pseudo Color (CR25, CR26, CR27 = X, 0, 0 or X, 1, 0 or X, 0, 1 and MR11 = 1)

This mode sets the part into 8-bit Pseudo-Color operation. The pixel port accepts 8-bits of pixel data which indexes a 30-bit word in the Look-Up Table RAM. The Look-Up Table is configured as a 256 location by 30 bits deep RAM (10 bits each for Red, Green and Blue). The output of the RAM drives the DACs with 30-bit data (10 bits each for Red, Green and Blue).

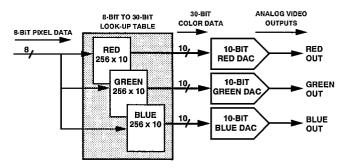


Figure 21. 8-Bit to 30-Bit Pseudo-Color Configuration

This mode allows for the display of 256 simultaneous colors out of a total palette of millions of addressable colors .

8-Bit "Standard" Pseudo Color (CR25, CR26, CR27 = X, 0, 0 or X, 1, 0 or X, 0, 1 and MR11 = 0)

This mode sets the part into 8-bit Pseudo-Color operation. The pixel port accepts 8-bits of pixel data which indexes a 24-bit word in the Look-Up Table RAM. The Look-Up Table is configured as a 256 location by 24 bits deep RAM (10 bits each for Red, Green and Blue). The output of the RAM drives the DACs with 24-bit data (8 bits each for Red, Green and Blue).

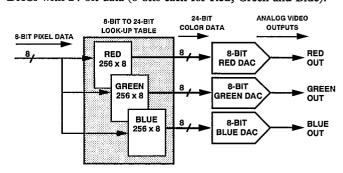


Figure 22. 8-Bit to 24-Bit Pseudo-Color Configuration

This mode allows for the display of 256 simultaneous colors out of a total palette of millions of addressable colors.

15-Bit "Gamma" True Color (CR24, CR25, CR26, CR27 = 0, 0, 1, 1 or 1, 0, 1, 1 and MR11 = 1)

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The part is set to 15-bit True-Color operation. The pixel port accepts 15-bits of color data which is mapped to the 5 LSBs of each of the red, green and blue palettes of the Look-Up Table RAM. The Look-Up Table is configured as a 32 location by 30 bits deep RAM (10 bits each for Red, Green and Blue). The output of the RAM drives the DACs with 30-bit data (10 bits each for Red, Green and Blue).

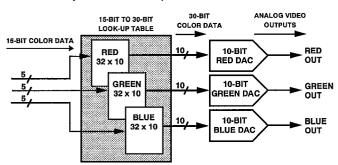


Figure 23. 15-Bit to 30-Bit True-Color Configuration
This mode allows for the display of 15-bit, Gamma-Corrected
True-Color Images.

15-Bit "Standard" True Color (CR24, CR25, CR26, CR27 = 0, 0, 1, 1 or 1, 0, 1, 1 and MR11 = 0)

The part is set to 15-bit True-Color operation. The pixel port accepts 15-bits of color data which is mapped to the 5 LSBs of each of the red, green and blue palettes of the Look-Up Table RAM. The Look-Up Table is configured as a 32 location by 24 bits deep RAM (8 bits each for Red, Green and Blue). The output of the RAM drives the DACs with 24-bit data (8 bits each for Red, Green and Blue).

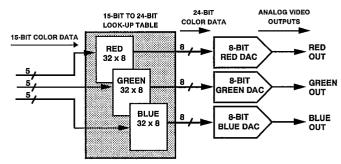


Figure 24. 15-Bit to 24-Bit True-Color Configuration
This mode allows for the display of 15-bit True-Color Images.

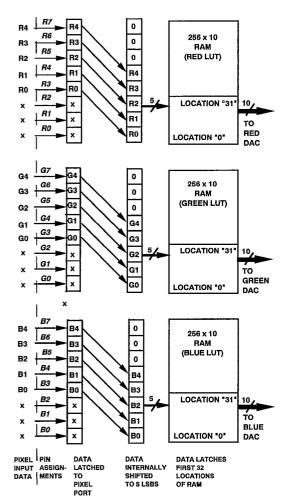


Figure 25. 15-Bit True-Color Mapping Using R3–R7, G3–G7 and B3–B7

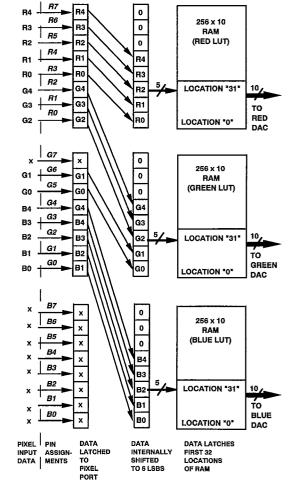


Figure 26. 15-Bit True-Color Mapping Using R0–R7 and G0–G6

PIXEL PORT MAPPING

The pixel data to the ADV7150 is automatically mapped in the parts pixel port as determined by the pixel data mode programmed (bits CR24–CR27 of Command Register 2).

Pixel data in the 24-bit True-Color modes is directly mapped to the 24 color inputs R0-R7, G0-G7 and B0-B7.

There are three modes of operation for 8-bit Pseudo Color. Each mode maps the input pixel data differently. Data can be input on one of the three color channels, R0-R7 or G0-G7 or B0-B7.

The part has two modes of operation for 15-bit True Color. In the first mode, data is input to the device over the red, green and blue channel (R3–R7, G3–G7 and B3–B7) and is internally mapped to locations 0 to 31 of the Look-Up Table (LUT) according to Figure 25. In the second mode, data is input to the device over just two of the color ports, red and green (R0–R7 and G0–G6) and is internally mapped to LUT locations 0 to 31 according to Figure 26. (Note: Data on unused pixel inputs is ignored.)

MICROPROCESSOR (MPU) PORT

The ADV7150 supports a standard MPU Interface. All the functions of the part are controlled via this MPU port. Direct access is gained to the Address Register, Mode Register and all the Control Registers as well as the Color Palette. The following sections describe the setup for reading and writing to all of the devices registers.

MPU Interface

The MPU interface (Figure 27) consists of a bidirectional, 10-bit wide databus and interface control signals \overline{CE} , CO, C1 and R/\overline{W} . The 10-bit wide databus is user configurable as illustrated.

Table II. Databus Width

| Databus Width | RAM/DAC Resolution | Read/Write Mode | |
|------------------|-----------------------|--------------------|--|
| 10-Bit | 10-Bit | 10-Bit Parallel | |
| 10-Bit | 8-Bit | 8-Bit Parallel | |
| 8-Bit | 10-Bit | 8+2 Byte | |
| 8-Bit | 8-Bit | 8-Bit Parallel | |

Register Mapping

The ADV7150 contains a number of on-board registers including the Mode Register (MR17–MR10), Address Register (A7–A0) and seven Control Registers as well as Red (R9–R0), Green (G9–G0) and Blue (B9–B0) Color Registers. These registers control the entire operation of the part. Figure 28 shows the internal register configuration.

Control lines C1 and C0 determine which register the MPU is accessing. C1 and C0 also determine whether the Address Register is pointing to the color registers and look-up table RAM or the control registers. If C1, C0 = 1, 0 the MPU has access to whatever control register is pointed to by the Address Register (A7–A0). If C1, C0 = 0, 1 the MPU has access to the Look-Up Table RAM (Color Palette) through the associated color registers. The \overline{CE} input latches data to or from the part.

The R/\overline{W} control input determines between read or write accesses. The Truth Tables (III and IV) show all modes of access to the various registers and color palette for both the 8-bit wide databus configuration and 10-bit wide databus configuration. It should be noted that after power-up, the devices MPU port is automatically set to 10-bit wide operation (see Power-On Reset section).

Color Palette Accesses

Data is written to the color palette by first writing to the address register of the color palette location to be modified. The MPU performs three successive write cycles for each of the red, green and blue registers (10-bit or 8-bit). An internal pointer moves from red to green to blue after each write is completed. This pointer is reset to red after a blue write or whenever the address register is written. During the blue write cycle, the three bytes of red, green and blue are concatenated into a single 30-bit/24-bit word and written to the RAM location as specified in the address register (A7–A0). The address register then automatically increments to point to the next RAM location and a similar red, green and blue palette write sequence is performed. The address register resets to 00H following a blue write cycle to color palette RAM location FFH.

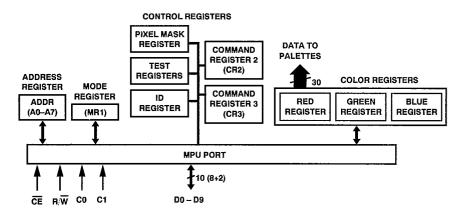


Figure 27. MPU Port and Register Configuration

Data is read from the color palette by first writing to the address register of the color palette location to be read. The MPU performs three successive read cycles from each of the red, green and blue locations (10-bit or 8-bit) of the RAM. An internal pointer moves from red to green to blue after each read is completed. This pointer is reset to red after a blue read or whenever the address register is written. The address register then automatically increments to point to the next RAM location and a similar red, green and blue palette read sequence is performed. The address register resets to 00H following a blue read cycle of color palette RAM location FFH.

Register Accesses

The MPU can write to or read from all of the ADV7150s registers. C0 and C1 determine whether the Mode Register or Address Register is being accessed. Access to these registers is direct. The Control Registers are accessed indirectly. The Address Register must point to the desired Control Register. Figure 28 along with the 8-bit and 10-bit Interface Truth Tables illustrate the structure and protocol for device communication over the MPU port.

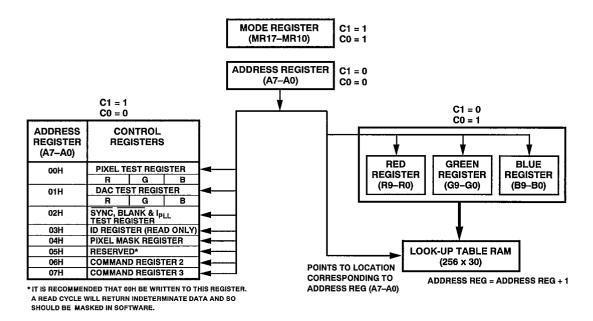


Figure 28. Internal Register Configuration and Address Decoding

Table III. Interface Truth Table (10-Bit Databus Mode)

| R/W | C1 | C0 | Databus (D9-D0) | Operation | Result |
|-----|----|----|--------------------|--|---|
| 0 | 1 | 1 | DB7-DB0 | Write to Mode Register | DB7–DB0 → MR17–MR10 |
| 0 | 0 | 0 | DB7-DB0 | Write to Address Register | $DB7-DB0 \rightarrow A7-A0$ |
| 0 | 1 | 0 | DB7–DB0 | Write to Control Registers (Particular Control Register Determined by Addre | $DB7-DB0 \rightarrow Control Registers$ ess Register) |
| 0 | 0 | 1 | DB9-DB0 | Write to RED Register | $DB9-DB0 \rightarrow R9-R0$ |
| 0 | 0 | 1 | DB9-DB0 | Write to GREEN Register | $DB9-DB0 \rightarrow G9-G0$ |
| 0 | 0 | 1 | DB9-DB0 | Write to BLUE Register | $DB9-DB0 \rightarrow B9-B0$ |
| | | | | Write RGB Data to RAM Location Pointed to Address Register = Address Register + 1 | by Address Register (A7–A0) |
| 1 | 1 | 1 | DB7-DB0 | Read Mode Register | $MR17-MR10 \rightarrow DB7-DB0$ |
| 1 | 0 | 0 | DB7-DB0 | Read Address Register | $A7-A0 \rightarrow DB7-DB0$ |
| 1 | 1 | 0 | DB7-DB0 | Read Control Registers | Register Data → DB7–DB0 |
| | | | | (Particular Control Register Determined by Addre | ess Register) |
| 1 | 0 | 1 | DB9-DB0 | Read RED RAM Location | $R9-R0 \rightarrow DB9-DB0$ |
| 1 | 0 | 1 | DB9-DB0 | Read GREEN RAM Location | $G9-G0 \rightarrow DB9-DB0$ |
| 1 | 0 | 1 | DB9-DB0 | Read BLUE RAM Location | $B9-B0 \rightarrow DB9-DB0$ |
| | | | | (RAM Location Pointed to by Address Register (Address Reg = Address Register + 1 | A7–A0)) |

DB = Data Bit.

Table IV. Interface Truth Table (8-Bit Databus Mode)*

65E D

| R/W | C1 | C0 | Databus (D7-D0) | Operation | Result |
|-----------------------|-----------------------|----------------------------|--|---|---|
| 0 0 0 | 1 0 1 | 1 0 0 | DB7-DB0 DB7-DB0 DB7-DB0 | Write to Mode Register Write to Address Register Write to Control Registers (Particular Control Register Determined by Addre | $\begin{array}{c} \text{DB7-DB0} \rightarrow \text{MR17-MR10} \\ \text{DB7-DB0} \rightarrow \text{A7-A0} \\ \text{DB7-DB0} \rightarrow \text{Control Registers} \\ \text{css} \ \textit{Register} \ (A7-A0)) \end{array}$ |
| 0 0 0 0 0 | 0 0 0 0 0 | 1 1 1 1 1 1 | DB9-DB2 DB1-DB0 DB9-DB2 DB1-DB0 DB9-DB2 DB1-DB0 | Write to RED Register Write to RED Register Write to GREEN Register Write to GREEN Register Write to BLUE Register Write to BLUE Register Write RGB Data to RAM Location Pointed to Address Register = Address Register + 1 | $DB9-DB2 \rightarrow R9-R2$ $DB1-DB0 \rightarrow R1-R0$ $DB9-DB2 \rightarrow G9-G2$ $DB1-DB0 \rightarrow G1-G0$ $DB9-DB2 \rightarrow B9-B2$ $DB1-DB0 \rightarrow B1-B0$ by Address Register (A7-A0) |
| 1 1 1 | 1 0 1 | 1 0 0 | DB7-DB0 DB7-DB0 DB7-DB0 | Read Mode Register Read Address Register Read Control Registers (Particular Control Register Determined by Ad | MR17-MR10 → DB7-DB0 A7-A0 → DB7-DB0 Register Data → DB7-DB0 Idress Register) |
| 1 1 1 1 1 | 0 0 0 0 0 | 1 1 1 1 1 | DB9-DB2 DB1-DB0 DB9-DB2 DB1-DB0 DB9-DB2 DB1-DB0 | Read RED RAM Location Read RED RAM Location Read GREEN RAM Location Read GREEN RAM Location Read BLUE RAM Location Read BLUE RAM Location (RAM Location Pointed to by Address Register (Address Register + 1) | $R9-R2 \rightarrow DB9-DB2$ $R1-R0 \rightarrow DB1-DB0$ $G9-G2 \rightarrow DB9-DB2$ $G1-G0 \rightarrow DB1-DB0$ $B9-B2 \rightarrow DB9-DB2$ $B1-B0 \rightarrow DB1-DB0$ $A7-A0))$ |

^{*}Writing or reading 10-bit data (DB9-DB0) over an 8-bit databus (D7-D0) requires two write or two read cycles.

DB = Data Bit.

Power-On Reset

On power-up of the ADV7150 executes a power-on reset operation. This initializes the pixel port such that the pixel sequence ABCD starts at A. The Mode Register (MR17-MR10), Command Register 2 (CR27-CR20) and Command Register 3 (CR37-CR30) have all bits set to a Logic "1."

The output clocking signals are also set during this reset period.

PRGCKOUT = CLOCK/32

LOADOUT = CLOCK/4

The power-on reset is activated when V_{AA} goes from 0 V to 5 V. This reset is active for 1 μs . The ADV7150 should not be accessed during this reset period.

REGISTER PROGRAMMING

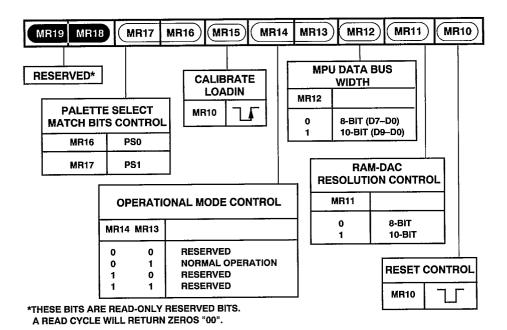
The following section describes each register, including Address Register, Mode Register and each of the seven Control Registers in terms of its configuration.

Address Register (A7-A0)

As illustrated in the previous tables, the C0 and C1 control inputs, in conjunction with this address register specify which control register, or color palette location is accessed by the MPU port. The address register is 8 bits wide and can be read from as well as written to. When writing to or reading from the color palette on a sequential basis, only the start address needs to be written. After a red, green and blue write sequence, the address register is automatically incremented.

[:]DB9-DB2 is mapped to D7-D0 on the first cycle

[:]DB1-DB0 is mapped to D1-D0 on the second cycle.



Mode Register 1 (MR1) (MR19-MR10)

MODE REGISTER MR1 (MR19-MR10)

The mode register is a 10-bit wide register. However, for programming purposes it may be considered as an 8-bit wide register (MR18 and MR19 are both reserved). It is denoted as MR17-MR10 for simplification purposes.

The diagram shows the various operations under the control of the mode register. This register can be read from as well written to. In read mode, if MR18 and MR19 are read back, they are both returned as zeros.

Mode Register (MR17-MR10) Bit Description Reset Control (MR10)

This bit is used to reset the pixel port sampling sequence. This ensures that the pixel sequence ABCD starts at A. It is reset by writing a "1" followed by a "0" followed by a "1." This bit must be run through this cycle during the initialization sequence.

RAM-DAC Resolution Control (MR11)

When this is programmed with a "1," the RAM is 30-bits deep (10 bits each for red, green and blue) and each of the three DACs is configured for 10-bit resolution. When MR11 is programmed with a "0," the RAM is 24-bits deep (8 bits each for red, green and blue) and the DACs are configured for 8-bit resolution. The two LSBs of the 10-bit DACs are pulled down to zero in 8-bit RAM-DAC mode.

MPU Databus Width (MR12)

This bit determines the width of the MPU port. It is configured as either a 10-bit wide (D9-D0) or 8-bit wide (D7-D0) bus. 10-bit data can be written to the device when configured in 8-bit wide mode. The 8 MSBs are first written on D7-D0, then the two LSBs are written over D1-D0. Bits D9-D8 are zeros in 8-bit mode.

Operational Mode Control (Test/Normal) (MR14-MR13)

When these bits are zero, the part operates in normal mode. All other combinations are used in conjunction with the devices various test/diagnostic modes, see "Test Diagnostics" section.

Calibrate LOADIN (MR15)

This bit automatically calibrates the on-board LOADIN/LOADOUT synchronization circuit. A "0" to "1" transition initiates calibration. This bit is set to "1" in normal operation, see "Pipeline Delay and Calibration" section. This bit must be run through this cycle during the initialization sequence.

Palette Select Match Bits Control (MR17-MR16)

These bits allow multiple palette devices to work together. When bits PS1 and PS0 match MR17 and MR16 respectively, the device is selected. If these bits do not match, the device is not selected and the analog video outputs drive 0 mA (see "Palette Priority Select Inputs" section).

CONTROL REGISTERS

The ADV7150 has 7 control registers. To access each register, two write operations must be performed. The first write to the address register specifies which of the 7 registers is to be accessed. The second access determines the value written to that particular control register.

Pixel Test Register

(Address Reg (A7-A0) = 00H)

This register is used when the device is in test/diagnostic mode. It is a 24-bit (8 bits each for RED, GREEN and BLUE) wide read-only register which allows the MPU to read data on the pixel port (see "Test Diagnostic" section).

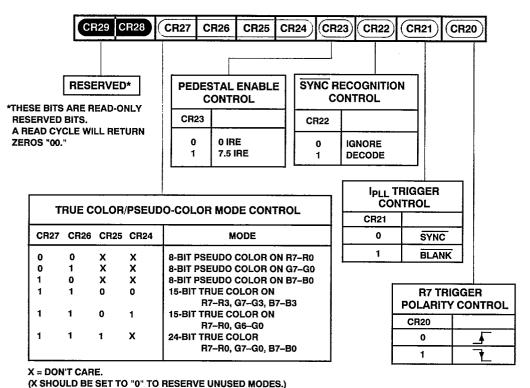
DAC Test Register

(Address Reg (A7-A0) = 01H)

This register is used when the device is in test/diagnostic mode. It is a 30-bit (10 bits each for RED, GREEN and BLUE) wide read-only register which allows MPU access to the DAC port (see "Test Diagnostic" section).

SYNC, BLANK and I_{PLL} Test Register (Address Reg (A7-A0) = 02H)

This register is used when the device is in test/diagnostic mode. It is a 3-bit wide (3 LSBs) read/write register which allows MPU



10 0 10 RESERVE GROSED MODES.)

Command Register 2 (CR2) (CR29–CR20)

access to these particular pixel control bits (see "Test Diagnostic" section).

ID Register

(Address Reg (A7-A0) = 03H)

This is an 8-bit wide "Identification" read-only register. For the ADV7150 it will always return the hexadecimal value 8EH.

Pixel Mask Register

(Address Reg (A7-A0) = 04H)

The contents of the pixel mask register are individually bit-wise logically AND-ed with the Red, Green and Blue pixel input stream of data. It is an 8-bit read/write register with D0 corresponding to R0, G0 and B0. For normal operation, this register is set with FFH

COMMAND REGISTER 2 (CR2)

(Address Reg (A7-A0) = 06H)

This register contains a number of control bits as shown in the diagram. CR2 is a 10-bit wide register. However for programming purposes, it may be considered as an 8-bit wide register (CR28 and CR29 are both reserved).

The diagram shows the various operations under the control of CR2. This register can be read from as well written to. In read mode, CR28 and CR29 are both returned as zeros.

COMMAND REGISTER 2 BIT DESCRIPTION R7 Trigger Polarity Control (CR20)

This bit is used when the device is in test/diagnostic mode. It determines whether the pixel data is latched into the test registers in the rising or falling edge of R7. (See "Test Diagnostic" Section.)

I_{PLL} Trigger Control (CR21)

This bit specifies whether the $I_{\rm PLL}$ output is triggered from \overline{BLANK} or \overline{SYNC} .

SYNC Recognition Control (CR22)

This bit specifies whether the video SYNC input is to be encoded onto the IOG analog output or ignored.

Pedestal Enable Control (CR23)

This bit specifies whether a 0 IRE or a 7.5 IRE blanking pedestal is to be generated on the video outputs.

True-Color/Pseudo-Color Mode Control (CR27-CR24)

These 4 bits specify the various color modes. These include a 24-bit true-color mode, two 15-bit true-color modes and three 8-bit pseudo color modes.

COMMAND REGISTER 3 (CR3)

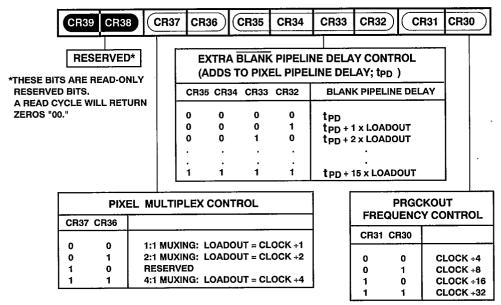
(Address Reg (A7-A0) = 07H)

This register contains a number of control bits as shown in the diagram. CR3 is a 10-bit wide register. However for programming purposes, it may be considered as an 8-bit wide register (CR38 and CR39 are both reserved).

The diagram shows the various operations under the control of CR3. This register can be read from as well written to. In read mode, CR38 and CR39 are both returned as zeros.

COMMAND REGISTER 3 BIT DESCRIPTION PRGCKOUT Frequency Control (CR31-CR30)

These bits specify the output frequency of the PRGCKOUT output. PRGCKOUT is a divided down version of the pixel CLOCK.



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D

Command Register 3 (CR3) (CR39-CR30)

BLANK Pipeline Delay Control (CR35-CR32)

These bits specify the additional pipeline delay that can be added to the BLANK function, relative to the overall device pipeline delay (t_{PD}) . As the \overline{BLANK} control normally enters the Video DAC from a shorter pipeline than the video pixel data, this control is useful in deskewing the pipeline differential.

Pixel Multiplex Control (CR37-CR36)

These bits specify the device's multiplex mode. It therefore also determines the frequency of the LOADOUT signal. LOAD-OUT is a divided down version of the pixel CLOCK.

DIGITAL-TO-ANALOG **CONVERTERS (DACS) AND** VIDEO OUTPUTS

The ADV7150 contains three high speed video DACs. The DAC outputs are represented as the three primary analog color signals IOR (red video), IOG (green video) and IOB (blue video). Other analog signals on the part include I_{PLL} and V_{REF} as well as complementary video outputs \overline{IOR} , \overline{IOG} , \overline{IOB} . These complementary outputs can be used to drive differentially terminated video loads, they will have equal but opposite output levels to IOR, IOG and IOB when loaded with a resistive load similar to IOR, IOG and IOB.

DACs and Analog Outputs

The part contains three matched 10-bit digital to analog converters. The DACs are designed using an advanced, high speed, segmented architecture. The bit currents corresponding to each digital input are routed to either IOR, IOG, IOB (bit = "1") or \overline{IOR} , \overline{IOG} , \overline{IOB} (bit = "0"). (Normally \overline{IOR} , \overline{IOG} , \overline{IOB} = GND).

The analog video outputs are high impedance current sources. Each of the these three RGB current outputs are specified to directly drive a 37.5 Ω load (doubly terminated 75 Ω).

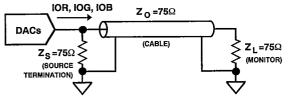


Figure 29. DAC Output Termination (Doubly Terminated 75 Ω Load)

Reference Input and R_{SET}

An external 1.23 V voltage reference is required to drive the analog outputs of the ADV7150. The reference voltage is connected to the V_{REF} input.

A resistor R_{SET} is connected between the R_{SET} input of the part and ground. For specified performance, R_{SET} has a value of 280 Ω . This corresponds to the generation of RS-343A video levels (with \overline{SYNC} on IOG and Pedestal = 7.5 IRE) into a doubly terminated 75 Ω load. Figure 30 illustrates the resulting video waveform and the Video Output Truth Table shows the corresponding control input stimuli.

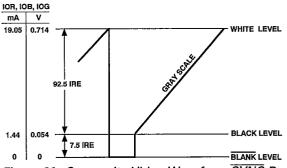


Figure 30. Composite Video Waveform SYNC Decoded on IOG; Pedestal = 7.5 IRE; R_{SET} = 280 Ω

Table V. Video Output Truth Table

| Description | IOG (mA) | IOR, IOB (mA) | SYNC | BLANK | DAC Input Data |
|----------------|--------------|------------------|------|-------|-------------------|
| WHITE LEVEL | 26.67 | 19.05 | 1 | 1 | 3FFH |
| VIDEO | Video + 9.05 | Video + 1.44 | 1 | 1 | Data |
| VIDEO to BLANK | Video + 1.44 | Video + 1.44 | 0 | 1 | Data |
| BLACK LEVEL | 9.05 | 1.44 | 1 | 1 | 000H |
| BLACK to BLANK | 1.44 | 1.44 | 0 | 1 | 000H |
| BLANK LEVEL | 7.62 | 0 | 1 | 0 | Hxxx |
| SYNC LEVEL | 0 | 0 | 0 | 0 | xxxH |

Variations on RS-343A

Various other video output configurations can be implemented by the ADV7150, including RS-170. Values of $R_{\rm SET}$ for particular output video formats/levels are calculated by using the equations for $R_{\rm SET}$ given in the "Pin Configuration" section. The table shows calculated values of $R_{\rm SET}$ for some of the most common variants on the RS-343A standard. The associated waveforms are shown in the diagrams.

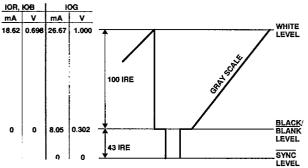


Figure 31. Composite Video Waveform SYNC Decoded on IOG; Pedestal = 0 IRE; $R_{SET} = 265 \Omega$

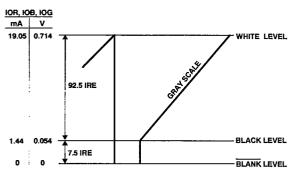


Figure 32. Composite Video Waveform Pedestal = 7.5 IRE; R_{SET} = 280 Ω

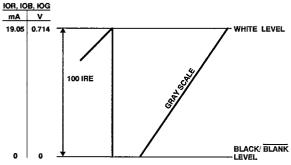


Figure 33. Composite Video Waveform Pedestal = 0 IRE; R_{SFT} = 259 Ω

| $R_{SET}(\Omega)$ | Video Signal |
|-------------------|---|
| 265 | $\overline{\text{SYNC}}$ decoded on IOG; Pedestal = 0 IRE |
| 280 | No $\overline{\text{SYNC}}$ decoded; Pedestal = 7.5 IRE |
| 259 | No $\overline{\text{SYNC}}$ decoded; Pedestal = 0 IRE |

I_{PLL} Synchronization Output Control

This output synchronization signal is used in applications where it is necessary to synchronize multiple palette devices (ADV7150 + ADV7151) to subpixel resolution. Each devices $I_{\rm PLL}$ output signal is in phase with its analog RGB output signal. If multiple devices have differing output delays, the time difference can be derived from the $I_{\rm PLL}$ signals. This time difference is then used to phase shift the CLOCK inputs on one or other of the devices inputs.

The $I_{\rm PLL}$ signal is internally triggered by either the falling edge of $\overline{\rm SYNC}$ or $\overline{\rm BLANK}$ as determined by CR21 of Command Register 2.

Using I_{PLL} as Digital SYNC Output

In some applications where it is not permissible to encode $\overline{\text{SYNC}}$ on green (IOG), I_{PLL} can be used as a separate TTL digital $\overline{\text{SYNC}}$ output. This has the advantage over an independent (of the ADV7150) $\overline{\text{SYNC}}$ in that it does not necessitate knowing the absolute pipeline delay of the part. This allows complete independence between LOADIN/Pixel Data and CLOCK. The $\overline{\text{SYNC}}$ input is connected to the device as normal with Bit CR22 of Command Register 2 set to "0" thereby preventing $\overline{\text{SYNC}}$ from being encoded onto IOG. Bit CR21 of Command Register 2 is set to "0," triggering I_{PLL} from the $\overline{\text{SYNC}}$ input. The output signal, terminated as shown, generates a TTL $\overline{\text{SYNC}}$ with correct pipeline delay which is capable of directly driving the composite $\overline{\text{SYNC}}$ signal of a computer monitor.

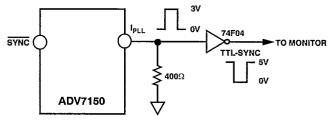
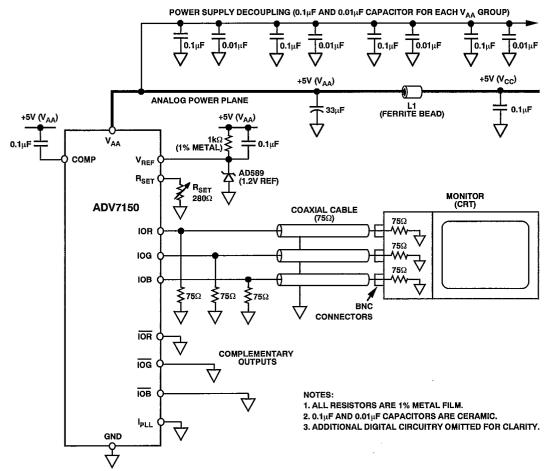


Figure 34. I_{PLL} as Digital SYNC Output

APPENDIX 1 BOARD DESIGN AND LAYOUT CONSIDERATIONS



Recommended Analog Circuit Layout

The ADV7150 is a highly integrated circuit containing both precision analog and high speed digital circuitry. It has been designed to minimize interference effects on the integrity of the analog circuitry by the high speed digital circuitry. It is imperative that these same design and layout techniques be applied to the system level design such that high speed, accurate performance is achieved. The "Recommended Analog Circuit Layout" shows the analog interface between the device and monitor.

The layout should be optimized for lowest noise on the ADV7150 power and ground lines by shielding the digital inputs and providing good decoupling. The lead length between groups of V_{AA} and GND pins should by minimized so as to minimize inductive ringing.

Ground Planes

The ground plane should encompass all ADV7150 ground pins, voltage reference circuitry, power supply bypass circuitry for the ADV7150, the analog output traces, and all the digital signal traces leading up to the ADV7150. The ground plane is the graphics board's common ground plane.

Power Planes

The ADV7150 and any associated analog circuitry should have its own power plane, referred to as the analog power plane (V_{AA}). This power plane should be connected to the regular PCB power plane (V_{CC}) at a single point through a ferrite bead.

This bead should be located within three inches of the ADV7150.

The PCB power plane should provide power to all digital logic on the PC board, and the analog power plane should provide power to all ADV7150 power pins and voltage reference circuitry.

Plane-to-plane noise coupling can be reduced by ensuring that portions of the regular PCB power and ground planes do not overlay portions of the analog power plane, unless they can be arranged such that the plane-to-plane noise is common mode.

Supply Decoupling

For optimum performance, bypass capacitors should be installed using the shortest leads possible, consistent with reliable operation, to reduce the lead inductance. Best performance is obtained with 0.1 μF ceramic capacitor decoupling. Each group of V_{AA} pins on the ADV7150 must have at least one 0.1 μF decoupling capacitor to GND. These capacitors should be placed as close as possible to the device.

It is important to note that while the ADV7150 contains circuitry to reject power supply noise, this rejection decreases with frequency. If a high frequency switching power supply is used, the designer should pay close attention to reducing power supply noise and consider using a three terminal voltage regulator for supplying power to the analog power plane.

Digital Signal Interconnect

The digital inputs to the ADV7150 should be isolated as much as possible from the analog outputs and other analog circuitry. Also, these input signals should not overlay the analog power plane.

Due to the high clock rates involved, long clock lines to the ADV7150 should be avoided to reduce noise pickup.

Any active termination resistors for the digital inputs should be connected to the regular PCB power plane ($V_{\rm CC}$), and not the analog power plane.

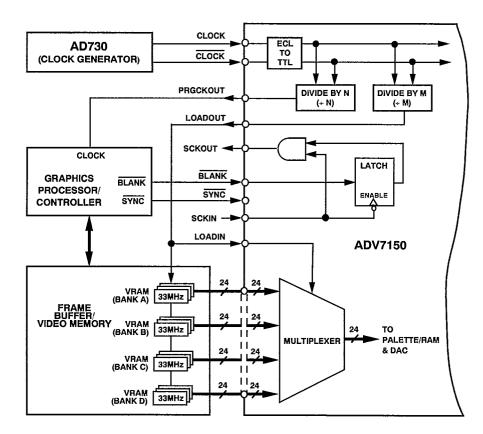
Analog Signal Interconnect

The ADV7150 should be located as close as possible to the output connectors to minimize noise pickup and reflections due to impedance mismatch.

The video output signals should overlay the ground plane, and not the analog power plane, to maximize the high frequency power supply rejection. Digital Inputs, especially Pixel Data Inputs and clocking signals (CLOCK, LOADOUT, LOADIN, etc.) should never overlay any of the analog signal circuitry and should be kept as far away as possible.

For best performance, the analog outputs (IOR, IOG, IOB) should each have a 75 Ω load resistor connected to GND. These resistors should be placed as close as possible to the ADV7150 so as to minimize reflections. Normally, the differential analog outputs (\$\overline{IOR}\$, \$\overline{IOG}\$, \$\overline{IOB}\$) are connected directly to GND. In some applications, improvements in performance are achieved by terminating these differential outputs with a resistive load similar in value to the video load. For a doubly terminated 75 Ω load, this means that \$\overline{IOR}\$, \$\overline{IOG}\$, \$\overline{IOB}\$ are each terminated with 37.5 Ω resistors.

APPENDIX 2 TYPICAL FRAME BUFFER INTERFACE



APPENDIX 3 10-BIT DACs AND GAMMA CORRECTION

10-Bit DACs

10-bit RAM-DAC resolution allows for nonlinear video correction, in particular Gamma Correction. The ADV7150 allows for an increase in color resolution from 24-bit to 30-bit effective color without the necessity of a 30-bit deep frame buffer. In true-color mode, for example, the part effectively operates as a 24-bit to 30-bit color look-up table.

Up to now we have assumed that there exists a linear relationship between the actual RGB values input to a monitor and the intensity produced on the screen. This, however, is not the case. Half scale digital input (1000 0000) might correspond to only 20% output intensity on the CRT (Cathode Ray Tube). The intensity (I_{CRT}) produced on a CRT by an input value I_{IN} is given by:

$$I_{CRT} = (I_{IN})^{\chi}$$

where χ ranges from 2.0 to 2.8.

If the individual values of χ for red, green and blue are known, then so called "Gamma Correction" can be applied to each of the three video input signals (I_{IN}) ;

therefore:

$$I_{IN(corrected)} = k(I_{IN})^{I/\chi}$$
 (k = 1, normally)

Traditionally, there has been a tradeoff between implementing a nonlinear graphics function, such as gamma correction, and color dynamic range. The ADV7150 overcomes this by increasing the individual color resolution of each of the red, green and blue primary colors from 8 bits per color channel to 10 bits per channel (24 bits to 30 bits).

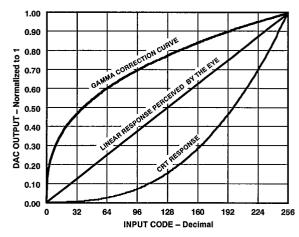
The table highlights the loss of resolution when 8-bit data is gamma-corrected to a value of 2.7 and quantized in a traditional 8-bit system. Note that there is no change in the 8-bit quantized data for linear changes in the input data over much of the transfer function. On the other hand, when quantized to 10 bits via the 10-bit RAMs and 10-bit DACs of the ADV7150, all changes on the input 8-bit data are reflected in corresponding changes in the 10-bit data.

The graph shows a typical gamma curve corresponding to a gamma value of 2.7. This is programmed to the red, green and blue RAMs of the color look-up table instead of the more traditional linear function. Different curves corresponding to any particular gamma value can be independently programmed to each of the red, green and blue RAMs.

Other applications of the 10-bit RAM-DAC include closed-loop monitor color calibration.

Gamma Correction 8 Bits vs. 10 Bits

| 8-Bit Data | Gamma Corrected (2.7) | Quantized to 8 Bits | Quantized to 10 Bits |
|------------|-----------------------------|------------------------|----------------------|
| 240 | 0.977797 | 250 | 1001 |
| 241 | 0.979304 | 250 | 1002 |
| 242 | 0.980807 | 251 | 1004 |
| 243 | 0.982306 | 251 | 1005 |
| 244 | 0.983801 | 251 | 1007 |
| 245 | 0.985292 | 252 | 1008 |
| 246 | 0.986780 | 252 | 1010 |
| 247 | 0.988264 | 252 | 1011 |
| 248 | 0.989744 | 253 | 1013 |
| 249 | 0.991220 | 253 | 1015 |
| 250 | 0.992693 | 254 | 1016 |
| 251 | 0.994161 | 254 | 1018 |
| 252 | 0.995626 | 254 | 1019 |
| 253 | 0.997088 | 255 | 1021 |
| 254 | 0.998546 | 255 | 1022 |
| 255 | 1.000000 | 255 | 1023 |



Gamma Correction Curve (Gamma Value = 2,70)

APPENDIX 4 MULTIPLE PALETTE APPLICATIONS

Palette Priority Select Inputs

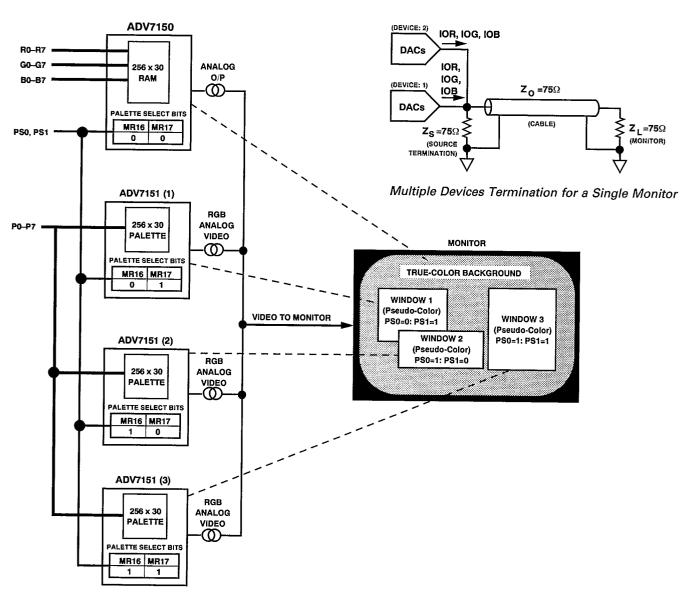
The palette priority selection inputs allow up to four separate palette devices to be used in a single system to drive a single monitor with subpixel resolution. The IOR, IOG and IOB analog video output signals of each device are connected together, as shown. Signal inputs (PS0, PS1) determine on a pixel by pixel basis which palette device drives the monitor. This allows for implementation of multiple windows applications with each device acting as an independent palette. During initialization, each device is assigned two match bits, MR16 (PS0) and MR17 (PS1) in Mode Register MR1. PS0 and PS1 inputs will select one of the preprogrammed devices at any instant when PS0, PS1 matches MR16, MR17, respectively. PS0 and PS1 are multiplexed similar to the pixel data, thus allowing for subpixel resolution. The diagrams show an example of one ADV7150

operating in conjunction with three ADV7151's (Pseudo-Color RAM-DACs). Each displayed window on the monitor is driven by one of the four devices, as determined on a pixel basis by PS0, PS1. Each device's analog output signals are connected together as shown.

Note: Only one palette device is selected at any particular instant. The analog output levels of the unselected devices will be $0\ \mathrm{mA}$.

Other applications for the palette priority function using a minimum of two devices (one ADV7150 and one ADV7151) include:

Cursor Overlay on 24-Bit Graphics Active Live Video Overlay (from Frame Grabber) Text/Character Generation and Overlay



Multiple Devices Driving a Multiwindow Application

APPENDIX 5 INITIALIZATION AND PROGRAMMING

ADV7150 Initialization

After power has been supplied, the ADV7150 must be initialized. The Mode Register and Control Registers must be set. The values written to the various registers will be determined by the desired operating mode of the part, i.e., True Color/Pseudo Color, 4:1 Muxing/2:1 Muxing, etc.

The following section gives examples of initialization of the ADV7150 operating in various modes.

Example 1

Write

Color Mode 24-Bit True Color Multiplexing 4:1

Databus 8-bit RAM-DAC Resolution 8-bit

SYNC Enabled on IOG Pedestal 7.5 IRE

| Registe | r Initialization | C1 | C0 | $\mathbb{R}/\overline{\mathbb{W}}$ | Comment |
|---------|--|----|----|------------------------------------|---|
| Write | 29H to Mode Register (MR1) | 1 | 1 | 0 | Resets to Normal Operation, 8-Bit Bus/RAM-DAC |
| Write | 28H to Mode Register (MR1) | 1 | 1 | 0 | *(Initializes Pipelining |
| Write | 29H to Mode Register (MR1) | 1 | 1 | 0 | *(" |
| Write | 09H to Mode Register (MR1) | 1 | 1 | 0 | *(Calibrates LOADOUT/LOADIN Timing |
| Write | 29H to Mode Register (MR1) | 1 | 1 | 0 | *(" |
| Write | 04H to Address Register (A7–A0) | 0 | 0 | 0 | Address Reg Points to Pixel Mask Register |
| Write | FFH to Pixel Mask Register | 1 | 0 | 0 | Sets the Pixel Mask to All "1"s |
| Write | 06H to Address Register (A7–A0) | 0 | 0 | 0 | Address Reg Points to Command Register 2 (CR2) |
| Write | ECH to Command Reg 2 (CR2) | 1 | 0 | 0 | Sets 24-Bit Color, 7.5 IRE, SYNC on Green (IOG) |
| Write | 07H to Address Register (A7–A0) | 0 | 0 | 0 | Address Reg Points to Command Register 3 (CR3) |
| Write | C0H to Command Reg 3 (CR3) | 1 | 0 | 0 | Sets 4:1 Multiplexing, PRGCKOUT = CLOCK/4 |
| *** | 3011 to 30111111111111111111111111111111111111 | | | | |
| | | | | | |
| Color I | Palette RAM Initialization | C1 | C0 | R/W | Comment |
| Write | 00H to Address Register (A7-A0) | 0 | 0 | 0 | Points to Color Palette RAM |
| Write | 00H (Red Data) to RAM Location (00H) | 0 | 1 | 0 | (Initializes Palette RAM |
| Write | 00H (Green Data) to RAM Location (00H) | 0 | 1 | 0 | (to a Linear Ramp** |
| Write | 00H (Blue Data) to RAM Location (00H) | 0 | 1 | 0 | (|
| Write | 01H (Red Data) to RAM Location (01H) | 0 | 1 | 0 | (|
| Write | 01H (Green Data) to RAM Location (01H) | 0 | 1 | 0 | (|
| Write | 01H (Blue Data) to RAM Location (01H) | 0 | 1 | 0 | (|
| • | | • | • | • | (|
| | | • | • | • | (|
| Write | FFH (Red Data) to RAM Location (FFH) | 0 | 1 | 0 | , |
| Write | FFH (Green Data) to RAM Location (FFH) | 0 | 1 | 0 | (|

^{*}These four command lines reset the ADV7150. The pipelines for each of the Red, Green and Blue pixel inputs are synchronously reset to the Multiplexer's "A" input. Mode Register bit MR10 is written by a "1" followed by "0" followed by "1." LOADIN/LOADOUT timing is internally synchronized by writing a "1" followed by a "0" followed by a "1" to Mode Register MR15.

0

(RAM Initialization Complete

1

FFH (Blue Data) to RAM Location (FFH)

^{**}This sequence of instructions would, of course, normally be coded using some form of loop instruction.

Example 2

Pedestal

Color Mode 24-Bit Gamma Corrected True Color (30 Bits)

0 IRE

Multiplexing 2:1
Databus 10-Bit
RAM-DAC Resolution 10-Bit
SYNC Ignored

| Registe | r Initialization | C1 | C0 | R/\overline{W} | Comment |
|---|---|---------------------------------|----------------------------|---------------------------------|--|
| Write | 2FH to Mode Register (MR1) | 1 | 1 | 0 | Resets to Normal Operation, 10-Bit Bus/RAM-DAC |
| Write | 2EH to Mode Register (MR1) | 1 | 1 | 0 | *(Initializes Pipelining |
| Write | 2FH to Mode Register (MR1) | 1 | 1 | 0 | *(" |
| Write | 0FH to Mode Register (MR1) | 1 | 1 | 0 | *(Calibrates LOADOUT/LOADIN Timing |
| Write | 2FH to Mode Register (MR1) | 1 | 1 | 0 | *(" |
| Write | 04H to Address Register (A7-A0) | 0 | 0 | 0 | Address Reg Points to Pixel Mask Register |
| Write | FFH to Pixel Mask Register | 1 | 0 | 0 | Sets the Pixel Mask to All "1s" |
| Write | 06H to Address Register (A7-A0) | 0 | 0 | 0 | Address Reg Points to Command Register 2 (CR2) |
| Write | E0H to Command Reg 2 (CR2) | 1 | 0 | 0 | Sets 24-Bit Color, 0 IRE, No SYNC |
| Write | 07H to Address Register (A7-A0) | 0 | 0 | 0 | Address Reg Points to Command Register 3 (CR3) |
| Write | 41H to Command Reg 3 (CR3) | 1 | 0 | 0 | Sets 4:1 Multiplexing, PRGCKOUT = CLOCK/8 |
| | | | | | |
| Color I | Palette RAM Initialization | C1 | C0 | R/\overline{W} | Comment |
| Color I Write | ···· | C1 0 | C0 0 | R/W 0 | |
| | Palette RAM Initialization 00H to Address Register (A7–A0) 000H (Red Data) to RAM Location (00H) | | | | Comment Points to Color Palette RAM (Initializes Palette RAM |
| Write | 00H to Address Register (A7-A0) | 0 | 0 | 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) | 0 | 0 | 0 | Points to Color Palette RAM |
| Write Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) | 0 0 0 | 0 1 1 | 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) 000H (Blue Data) to RAM Location (00H) | 0 0 0 0 | 0 1 1 1 | 0 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write Write Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) 000H (Blue Data) to RAM Location (00H) xxxH (Red Data) to RAM Location (01H) | 0 0 0 0 0 | 0 1 1 1 1 | 0 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write Write Write Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) 000H (Blue Data) to RAM Location (00H) xxxH (Red Data) to RAM Location (01H) xxxH (Green Data) to RAM Location (01H) | 0 0 0 0 0 | 0 1 1 1 1 1 | 0 0 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write Write Write Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) 000H (Blue Data) to RAM Location (00H) xxxH (Red Data) to RAM Location (01H) xxxH (Green Data) to RAM Location (01H) | 0 0 0 0 0 | 0 1 1 1 1 1 | 0 0 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write Write Write Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) 000H (Blue Data) to RAM Location (00H) xxxH (Red Data) to RAM Location (01H) xxxH (Green Data) to RAM Location (01H) | 0 0 0 0 0 | 0 1 1 1 1 1 | 0 0 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write Write Write Write Write Write . | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) 000H (Blue Data) to RAM Location (00H) xxxH (Red Data) to RAM Location (01H) xxxH (Green Data) to RAM Location (01H) xxxH (Blue Data) to RAM Location (01H) | 0 0 0 0 0 0 0 | 0 1 1 1 1 1 | 0 0 0 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |
| Write Write Write Write Write Write Write Write | 00H to Address Register (A7-A0) 000H (Red Data) to RAM Location (00H) 000H (Green Data) to RAM Location (00H) 000H (Blue Data) to RAM Location (00H) xxxH (Red Data) to RAM Location (01H) xxxH (Green Data) to RAM Location (01H) xxxH (Blue Data) to RAM Location (01H) | 0 0 0 0 0 0 0 | 0 1 1 1 1 1 | 0 0 0 0 0 0 0 | Points to Color Palette RAM (Initializes Palette RAM |

65E D

REGISTER DIAGNOSTIC TESTING

The previous examples show the register initialization sequence for the ADV7150. These show control data going to the registers and palette RAM. As well as this writing function, it may also be necessary, due to system diagnostic requirements, to confirm that correct data has been transferred to each register and palette RAM location. There are two ways to incorporate register value/RAM value checking:

1. READ after each WRITE: After data is written to a particular register, it can be read back immediately. The following table shows an example with Command Registers CR2 and CR3.

| C1 | C0 | R/\overline{W} | D0-D7 | Comment |
|----|----|------------------|-------|---------------------------------|
| 0 | 0 | 0 | 06H | Select Command Register 2 (CR2) |
| 1 | 0 | 0 | E0H | Sets 24-Bit True-Color |
| 1 | 0 | 1 | E0H | Command Reg 2 Value Read-Back |
| 0 | 0 | 0 | 07H | Select Command Register 3 (CR3) |
| 1 | 0 | 0 | 40H | Set 2:1 Mux Mode |
| 1 | 0 | 1 | 40H | Command Reg 3 Value Read-Back |

 READ after all WRITEs completed: All registers and the color palette RAM are written to and set. Once this is complete, all registers are again accessed but this time in Read-Only mode. The table below shows this method for Command Registers CR2 and CR3.

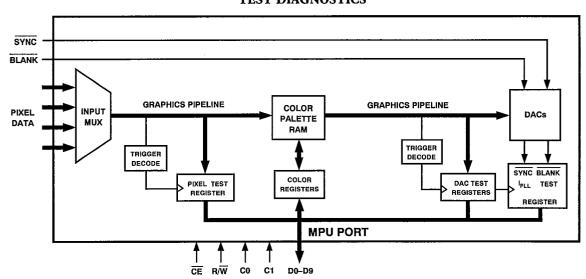
| C1 | C0 | R/\overline{W} | D0-D7 | Comment |
|----|----|------------------|-------------|---------------------------------|
| 0 | 0 | 0 | 06H | Select Command Register 2 (CR2) |
| 1 | 0 | 0 | E0H | Sets 24-Bit True-Color |
| 0 | 0 | 0 | 07 H | Select Command Register 3 (CR3) |
| 1 | 0 | 0 | 40H | Set 2:1 Mux Mode |
| 0 | 0 | 0 | 06H | Select CR2 |
| 1 | 0 | 1 | E0H | CR2 Value Read-Back |
| 0 | 0 | 0 | 07H | Select CR3 |
| 1 | 0 | 1 | 40H | CR3 Value Read-Back |
| 1 | 0 | 1 | 40H | CR3 Value Read-Back |

It is clear that this latter case requires more command lines than the previous READ after each WRITE case.

^{*}These four command lines reset the ADV7150. The pipelines for each of the Red, Green and Blue pixel inputs are synchronously reset to the Multiplexer's "A" input. Mode Register bit MR10 is written by a "1" followed by "0" followed by "1." LOADIN/LOADOUT timing is internally synchronized by writing a "1" followed by a "0" followed by a "1" to Mode Register MR15.

^{**}Data for a gamma curve characteristic is obtainable in Appendix 3.

APPENDIX 6 TEST DIAGNOSTICS



Test/Diagnostic Block Diagram

The ADV7150 contains on-board circuitry which enables both device and system level test diagnostics. The test circuitry can be used to test the frame buffer memory as well as the functionality of the ADV7150. A number of test registers are integrated into the part which effectively allow for monitoring of the graphics pipeline. Pixel data is read from the graphics pipeline independent of the pixel CLOCK. The pixel data itself contains the triggering information that latches data into the test registers. This allows for system diagnostics in a continuously clocked graphics system. The test register data is then read by the microprocessor over the MPU.

Access to the test registers is as described in the "Microprocessor (MPU) Port" section. This section also gives the address decode locations for the various test registers.

Test Trigger

The test trigger is decoded from the pixel data stream. Bit R7 of the RED channel is assigned the task of latching pixel data into the test registers. A "0" to "1" or a "1" to "0" (as determined by bit CR20 of Command Register 2) transition on R7, fills the test register with the corresponding pixel data. This effectively means that a sequence of data travels along the graphics pipeline, with the test registers taking a sample only when there is a transition on Bit R7. The following example shows a sequence with the ADV7150 preset to sample the graphics pipeline on a low-to-high transition of R7.

| Pixel 0: | 0000 | |
|------------|-------|----------------------------------|
| Pixel 1: | 0000 | |
| Pixel 2: | 0001 | Pixel 2 Latched to Test Register |
| Pixel 3: | 0000 | |
| | • • • | |
| | | |
| Pixel n-1: | 1110 | |
| Pixel n: | 1111 | Pixel n Latched to Test Register |
| Pixel n: | 1111 | |
| | | |

Pixel 2, in the above example, initially gets latched into the Pixel Test Register. Pixel 2 continues down the graphics pipe-

line and sometime later gets latched into the DAC Test Register. This data is then read in turn from each of the test registers over the MPU port. To ensure that Pixel 2 has propagated to each test register, the next pixel (Pixel n) should not be entered into the ADV7150s pipeline until at least a time corresponding to twice the devices pipeline delay (2 \times t_{PD}). The Test Registers must be read in a time sufficiently after the particular test pixel is entered and before the next test pixel enters the device.

Pixel Test Register

The read-only Pixel Test Register is 24 bits wide, 8 bits each for red, green and blue. It is situated directly after the Pixel Mask Register. After data is latched into this register by a transition on R7, it is read in three cycles over the MPU Port as described in the "Microprocessor (MPU) Port" section.

DAC Test Register

The DAC Test Register is latched with data some CLOCKs after the Pixel Test Register. The DAC Test Register is a 30-bit wide read-only register, corresponding to 10 bits each for red, green and blue data. It is located after the Color Palette RAM. If the RAM-DAC is in 8-bit resolution mode, the upper two bits of the red, green and blue data will be zero. After data is latched into the DAC Test Register by a transition on R7, it is read in three or six cycles over the MPU Port as described in the "Microprocessor (MPU) Port" section.

SYNC, BLANK and I_{PLL} Test Register

This is an 8-bit wide register but with only three effective bits. The three lower bits correspond to \overline{SYNC} , \overline{BLANK} and I_{PLL} respectively. The upper bits should be masked in software. This register is at the same position in the graphics pipeline as the DAC Test Register. When pixel data is latched into the DAC Test Register, the corresponding status of \overline{SYNC} , \overline{BLANK} and I_{PLL} is latched into this register. It is read over the MPU Port as described in the "Microprocessor (MPU) Port" section.

(Note: If \overline{BLANK} is low, the corresponding pixel data to the DAC Test Register will be all "0"s.)

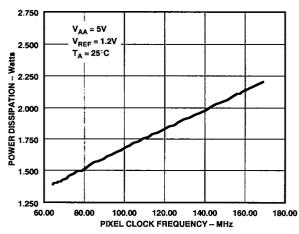
APPENDIX 7 THERMAL AND ENVIRONMENTAL CONSIDERATIONS

The ADV7150 is a very highly integrated monolithic silicon device. This high level of integration, in such a small package, inevitably leads to consideration of thermal and environmental conditions which the ADV7150 must operate in. Reliability of the device is significantly enhanced by keeping it as cool as possible. In order to avoid destructive damage to the device, the absolute maximum junction temperature of 150°C must never be exceeded. Certain applications, depending on pixel data rates, will require forced air cooling, external heatsinks or other cooling. The following data is intended as a guide in evaluating the operating conditions of a particular application so that optimum device and system performance is achieved.

It should be noted that information on package characteristics published herein may not be the most up to date at the time of reading this. Advances in package compounds and manufacture will inevitably lead to improvements in the thermal data. Please contact your local sales office for the most up-to-date information.

Power Dissipation

The diagram shows graphs of power dissipation in watts vs. pixel clock frequency for the ADV7150.



*THE 'TYPICAL ON-SCREEN PATTERN' CORRESPONDS TO LINEAR CHANGES IN THE PIXEL INPUT (IE, A BLACK TO WHITE RAMP). IN GENERAL, COLOR IMAGES TEND TO APPROXIMATE THIS CHARACTERISTIC.

Typical Power Dissipation vs. Pixel Rate

Package Characteristics

The graphs of thermal characteristics show typical information for the ADV7150 (160-Lead Plastic QFP) using various values of Airflow.

Junction to Case $(\theta_{\rm JC})$ Thermal Resistance for this particular part is:

 θ_{IC} (160-Lead Plastic QFP) = 6.7°C/W

(Note: θ_{JC} is independent of airflow.)

Table A. Thermal Characteristics vs. Airflow

| Air Velocity (Linear feet/min) | 0 (Still Air) | 50 | 100 | 200 |
|-----------------------------------|------------------|----|-----|-----|
| θ _{JA} (°C/W) | | | | |
| No Heatsink | 37 | 32 | 30 | 28 |
| EG&G D10850-40 Heatsink | 28 | 24 | 22 | 19 |
| EG&G D10851-36 Heatsink | 32 | 24 | 19 | 14 |

Thermal Model

The junction temperature of the device in a specific application is given by:

$$T_{J} = T_{A} + P_{D} (\theta_{JC} + \theta_{CA})$$
 (1)

OI

$$T_{I} = T_{A} + P_{D}(\theta_{IA}) \tag{2}$$

where:

 $T_I = Junction Temperature of Silicon (°C)$

 $T_A =$ Ambient Temperature (°C)

 P_D = Power Dissipation (W)

 θ_{IC} = Junction to Case Thermal Resistance (°C/W)

 θ_{CA} = Case to Ambient Thermal Resistance (°C/W)

 θ_{IA} = Junction to Ambient Thermal Resistance (°C/W)

Heatsinks

The maximum silicon junction temperature should be limited to 100° C. Temperatures greater than this will reduce long term device reliability. To ensure that the silicon junction temperature stays within prescribed limits, the addition of an external heatsink may be necessary. Heatsinks, such as the Deltem D10850-40 and D10851-36 from EG&G WAKEFIELD ENGINEERING will reduce θ_{JA} as shown in the Thermal Characteristics vs. Airflow table.

21693-7 5-10%

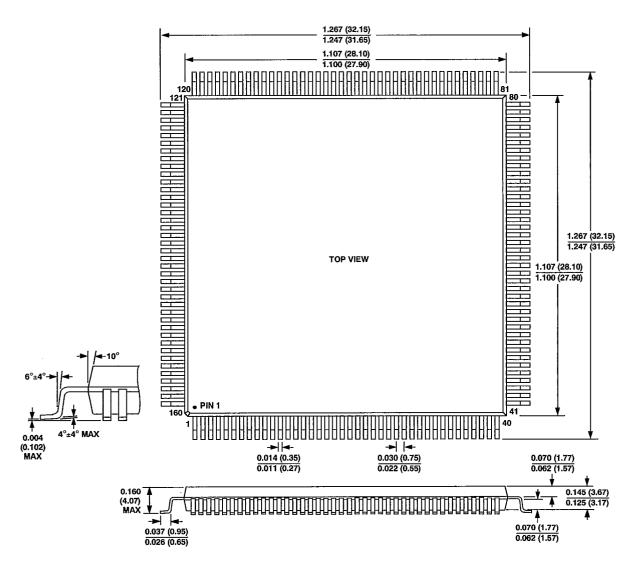
ADV7150

APPENDIX 8

PACKAGE OUTLINE DIMENSIONS

Outline Dimensions shown in inches and (mm).

S-160 160-Lead Plastic Quad Flatpack



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